

LD1071

16 Channel Output LED Driver with 14 bit PWM
Controller

Ver. 1.0 / Mar. 2009

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LD1071 Revision History

Version	Contents	Transfer Date
1.0	- First Version	2009.03.12

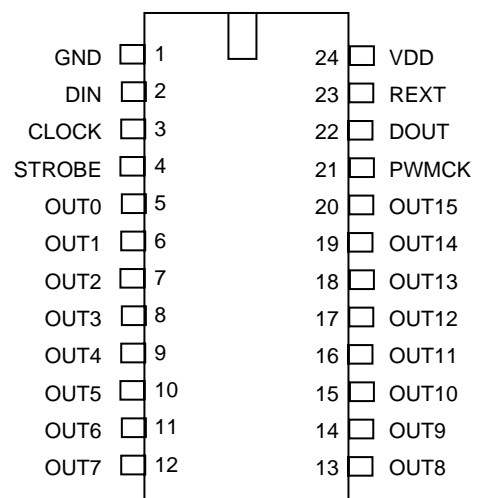
DESCRIPTION

The LD1071 is specifically designed for LED and LED display applications using PWM(Pulse Width Modulation) control with 14 bit color depth. The LD1071 provides a constant output current for driving the LEDs against for the variation of LED forward voltage(V_f). The constant output current can be preset through an external resistor. Moreover, the preset output current with external resistor can be programmed up to 256 levels for LED global brightness adjustment. The LD1071 consists of 16 bit shift registers, latches, and-gates, constant current driver and 14 bit PWM controller.

FEATURES

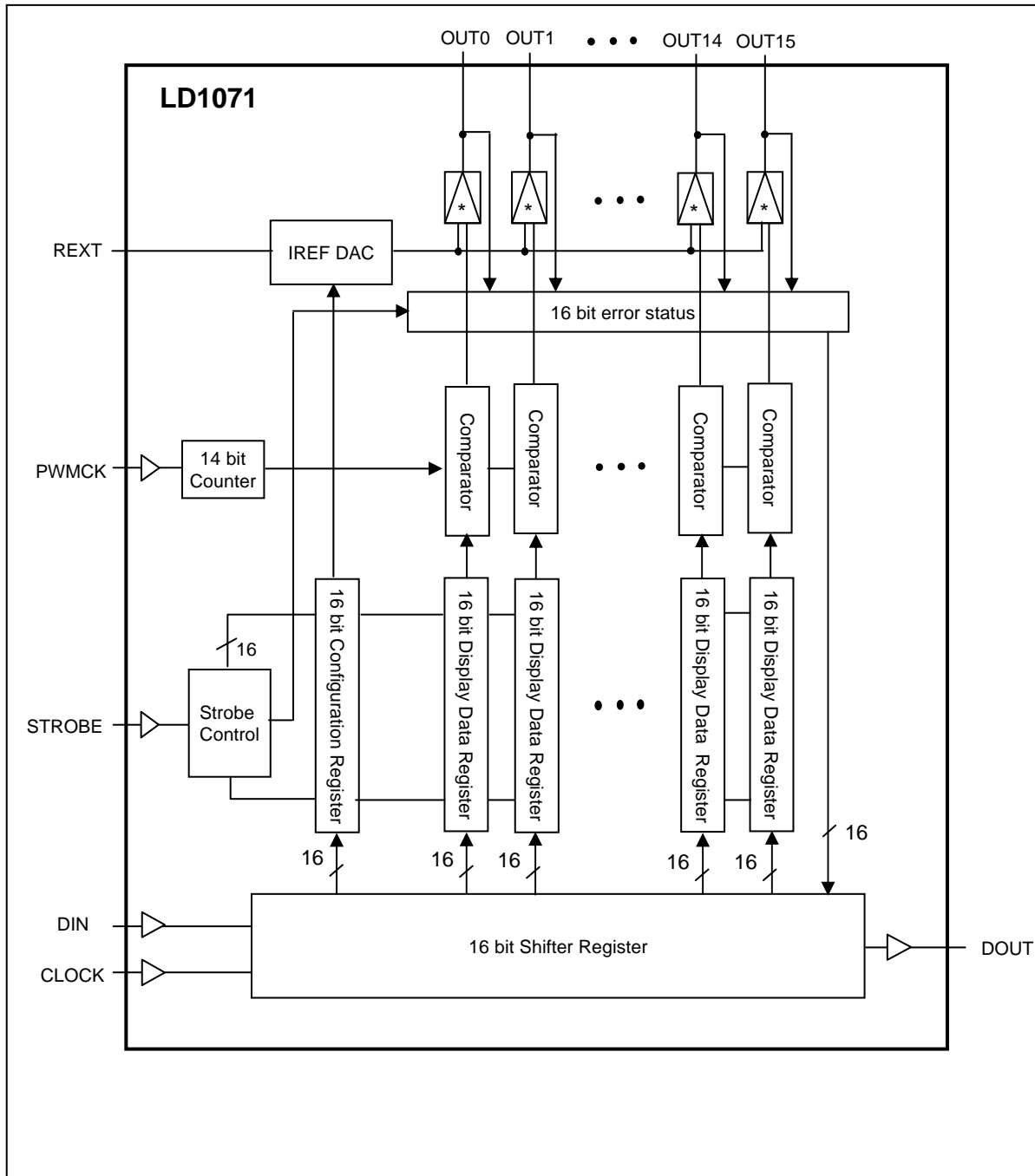
- Output current : set-up at 5mA to 45mA with an external resistor
(when VDD=3.3V, Iout : 5mA ~ 30mA)
- Include error detection circuit
- 16 constant current output channels
- 14 bit gray scale PWM control
- 8 bit programmable output current control
- Constant current accuracy
 - Pin to pin deviation : < $\pm 3\%$ (Max)
 - Chip to chip deviation : < $\pm 6\%$ (Max)
- 3.3V / 5V CMOS compatible input
- Package : LD1071-SP (SOP-24), LD1071-SS (SSOP-24)
- Maximum CLOCK input frequency : 25MHz
- Maximum PWMCK input frequency : 25MHz

PIN CONFIGURATION



PIN DESCRIPTION

PIN NO.	PIN NAME	DESCRIPTION
1	GND	Ground signal
2	DIN	Serial input data
3	CLOCK	Shift input clock for serial input data DIN(Rising Edge Clocking)
4	STROBE	Data strobe signal. This pin is a pull-down type.
5~12 13~20	OUTn	Constant current outputs, n = 0 ~ 15
21	PWMCK	PWM gray scale clock signal. This pin is a pull-up type.
22	DOUT	Serial data output
23	REXT	Connect the resistor between this pin and GND to set up the constant output current for all the OUTn.
24	VDD	Power supply signal (3.3V/5V)

BLOCK DIAGRAM


ELECTRICAL CHARACTERISTICS
ABSOLUTE MAXIMUM RATINGS

(Ta = 25°C)

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V _{DD}	0~7.0	V
Output Voltage	V _{OUT}	-0.5~13.5	V
Output Current	I _{OUT}	450	mA
Input Voltage	V _{IN}	-0.4~V _{DD} +0.4	V
GND Terminal Current	I _{GND}	960	mA
CLOCK Frequency	f _{CK}	25	MHz
PWMCK Frequency	f _{PWMCK}	25	MHz
Power Dissipation	SOP	1.67	W
	SSOP	1.48	
Thermal Resistance (On PCB, TA = 25)	SOP	75	/W
	SSOP	85	
Operating Temperature	T _{opr}	-40~85	°C
Storage Temperature	T _{stg}	-55~150	°C

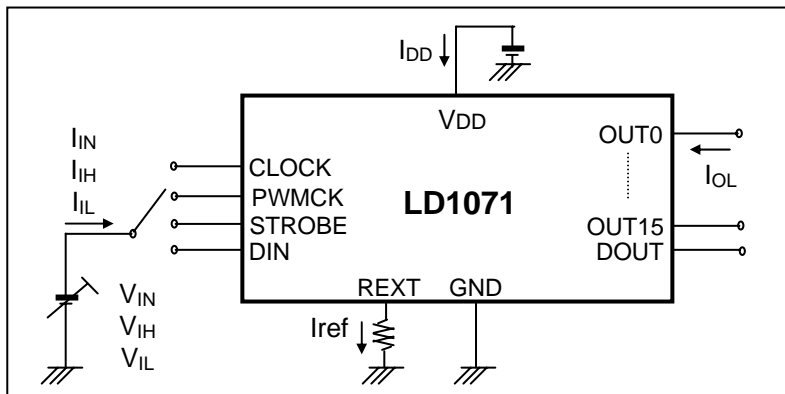
RECOMMENDED OPERATING CONDITIONS

DC CHARACTERISTICS		SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage		V_{DD}	4.5	5	5.5	V
LED Driver Output Voltage		V_{OUT}			13.5	V
Input Voltage	“H” Level	V_{IH}	$0.8V_{DD}$	-	V_{DD}	V
	“L” Level	V_{IL}	GND	-	$0.2V_{DD}$	
Output Voltage	DOUT	V_{OL}	-	-	$0.2V_{DD}$	V
		V_{OH}	$0.8V_{DD}$	-	-	
High Level Output Current		I_{OH}			-1	mA
Low Level Output Current		I_{OL}			1	mA
LED Driver Output Current		I_{OUT}			20	mA
Operating Free-air Temperature Range			-40		85	°C
AC CHARACTERISTICS		SYMBOL	MIN.	TYP.	MAX.	UNIT
CLOCK Frequency		f_{CK}			25	MHz
PWMCK Frequency	@5V	f_{PWMCK}			25	MHz
	@3.3V	f_{PWMCK}			20	MHz
Pulse Width	CLOCK	t_{WH0} / t_{WL0}	20			ns
	PWMCK	t_{WH1}	40			ns
	STROBE	t_{WH2}	40			ns
Setup Time		t_{setup}	15			ns
Hold Time		t_{hold}	15			ns

ELECTRICAL CHARACTERISTICS (VDD = 5V, Ta = 25°C)

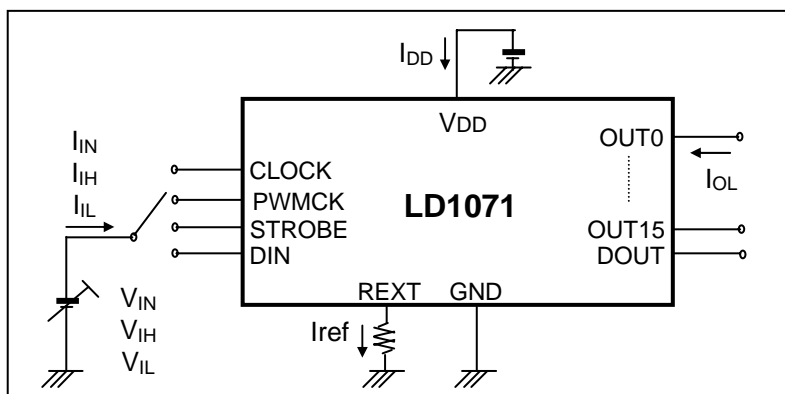
Parameter		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input Voltage	H Level	VIH	-	0.7VDD		VDD	V
	L Level	VIL	-	GND		0.3VDD	
Output Leakage Current		IOZ	VOH=6.0V			1	uA
Output Voltage	DOUT	VOL	IOL=1mA			0.2VDD	V
		VOH	IOH=1mA	0.8VDD			
Output Current1 Pin to Pin Deviation		IOLPP1	REXT=500 IOUT=40mA, VOUT=1.5V		±1.5	±3.0	%
Output Current1 Chip to Chip Deviation		IOLCC1	REXT=500 IOUT=40mA, VOUT=1.5V		±3.0	±6.0	%
Output Current vs. Supply Voltage Regulation		%/VDD	REXT=500 IOUT=40mA, VOUT=1.5V		±0.5	±1.0	%/V
Pull Up Resistor		RINUP	-	100	200	400	kΩ
Pull Down Resistor		RINDN	-	100	200	400	
Supply Current		IOFF1	REXT=Open, OUTn=OFF REF=FFh, PWM=Gray0	-	0.4	0.8	mA
		IOFF2	REXT=500, OUTn=OFF REF=FFh, PWM=Gray0	-	4.5	7.0	

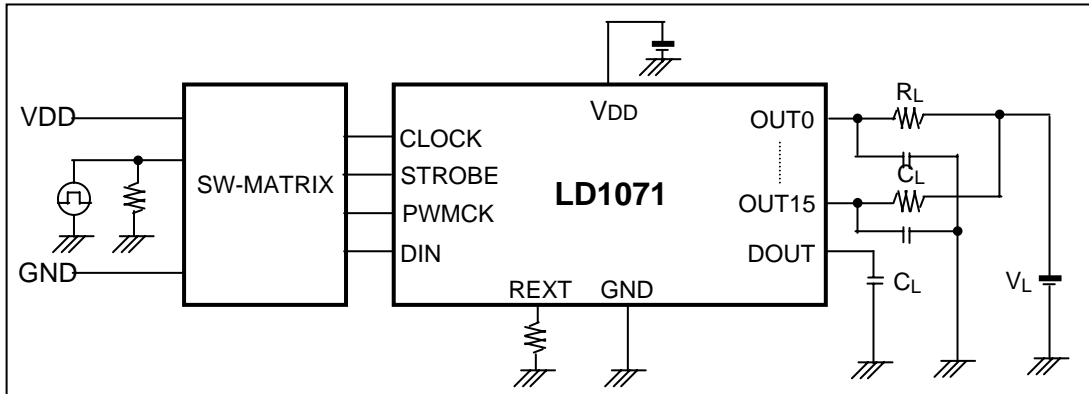
(Note) REF : Constant Current Control Value (CR[7:0] of Configuration Register)

DC CHARACTERISTIC TEST CIRCUIT


ELECTRICAL CHARACTERISTICS
(VDD = 3.3V, Ta = 25°C)

Parameter		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input Voltage	H Level	VIH	-	0.7VDD		VDD	V
	L Level	VIL	-	GND		0.3VDD	
Output Leakage Current		IOZ	VOH=6.0V			1	uA
Output Voltage	DOUT	VOL	IOL=1mA			0.2VDD	V
		VOH	IOH=1mA	0.8VDD			
Output Current1 Pin to Pin Deviation		IOLPP1	REXT=500 IOUT=36mA, VOUT=1.5V		± 1.5	± 3.0	%
Output Current1 Chip to Chip Deviation		IOLCC1	REXT=500 IOUT=36mA, VOUT=1.5V		± 3.0	± 6.0	%
Output Current vs. Supply Voltage Regulation		%/VDD	REXT=500 IOUT=36mA, VOUT=1.5V		± 0.5	± 1.0	%/V
Pull Up Resistor		RINUP	-	150	300	500	kΩ
Pull Down Resistor		RINDN	-	150	300	500	
Supply Current		IOFF1	REXT=Open, OUTn=OFF REF=FFh, PWM=Gray0	-	0.4	0.6	mA
		IOFF2	REXT=500, OUTn=OFF REF=FFh, PWM=Gray0	-	4.5	7.0	

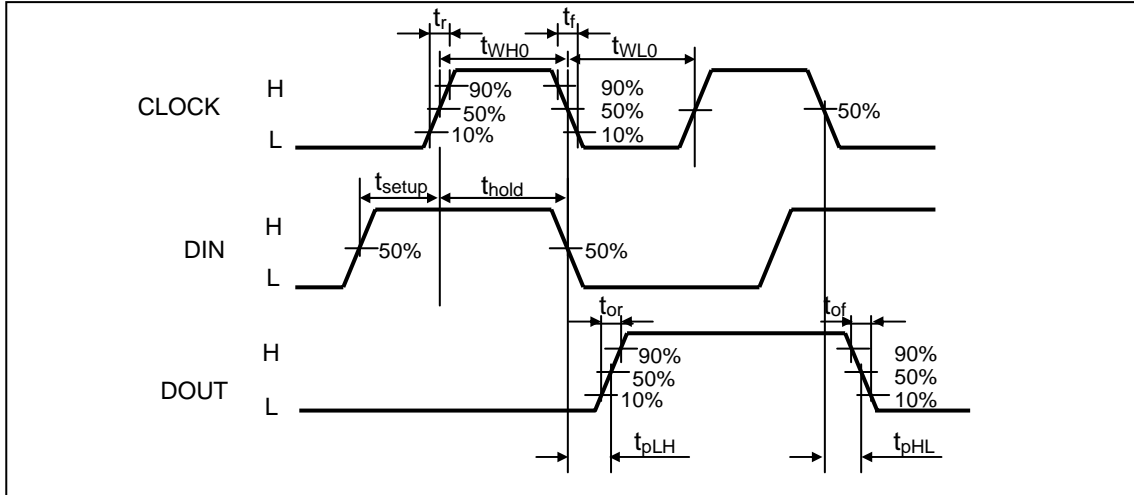
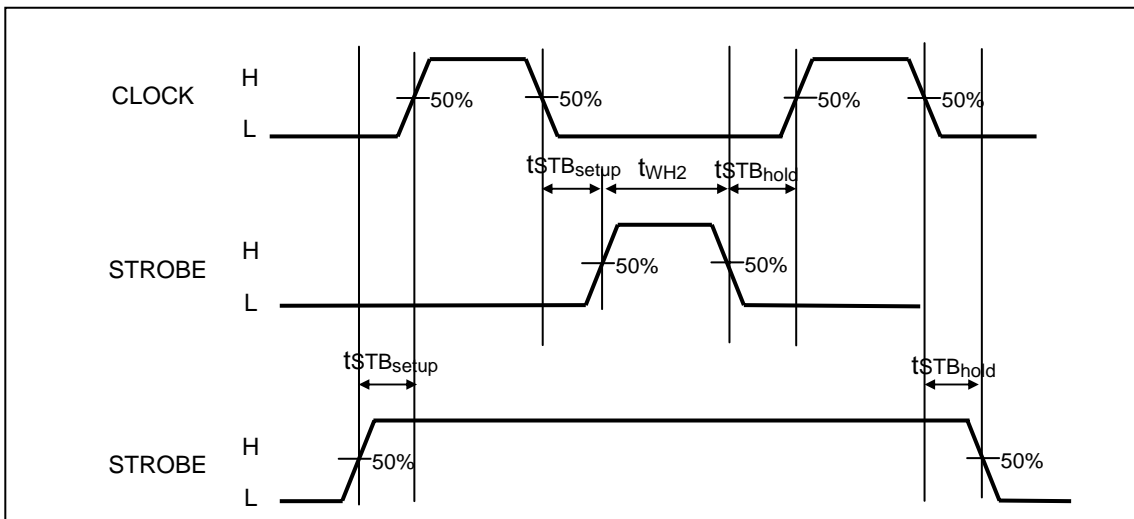
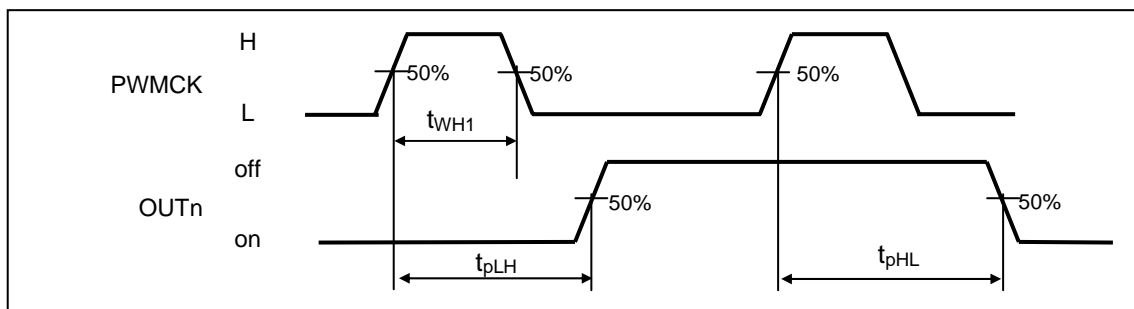
(Note) REF : Constant Current Control Value (CR[7:0] of Configuration Register)
DC CHARACTERISTIC TEST CIRCUIT


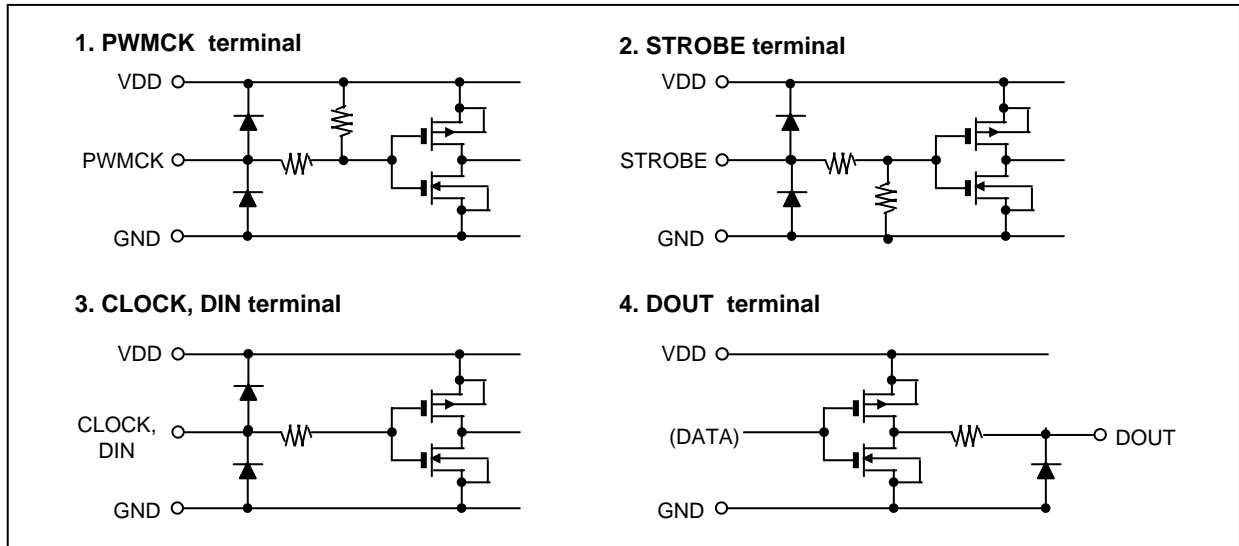
AC CHARACTERISTIC TEST CIRCUIT

SWITCHING CHARACTERISTICS

(Ta = 25°C unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation Delay Time ("L" to "H")	CLOCK-DOUT	t_{pLH}	V _{DD} = 5.0V V _{IH} = V _{DD} V _{IL} = GND f _{CK} = 10MHz R _{EXT} = 1590 I _{OUT} = 19.1mA C _L = 10.0pF R _L = 150 V _L = 4.5V	-	10	20	ns
	PWMCK-OUTn			-	-	50	
Propagation Delay Time ("H" to "L")	CLOCK-DOUT	t_{pHL}		-	10	20	ns
	PWMCK-OUTn			-	-	30	
Maximum CLOCK Frequency		f _{CKMAX} (*1)		-	10	25	MHz
Maximum PWMCK Frequency		f _{PWMCKMAX} (*1)		-	8	25	MHz
Pulse Width	CLOCK	t _{WH0} / t _{WL0}		15	20	-	ns
	PWMCK	t _{WH1}		15	20	-	ns
	STROBE	t _{WH2}		15	20	-	ns
Data Set Up Time		t _{setup} (D)		10	15	-	ns
Data Hold Time		t _{hold} (D)	10	15	-		
STROBE Set Up Time	LH	t _{STBSetup}	10	15	-	ns	
	HL		10	15	-		
STROBE Hold Time	LH	t _{STBhold}	10	-	-	ns	
	HL		10	-	-		
Maximum Clock Rise Time		t _r	-	-	30	ns	
Maximum Clock Fall Time		t _f	-	-	30		
Output Rise Time (OUTn)		t _{or}	-	-	30	ns	
Output Fall Time (OUTn)		t _{of}	-	-	30		
Global Latch Set Up Time		t _{glc}	20	-	-	ns	

*1 : Cascade Operation

TIMING WAVEFORM
CLOCK-DIN-DOUT

CLOCK-STROBE

PWMCK-OUTn


EQUIVALENT CIRCUIT OF INPUTS AND OUTPUTS


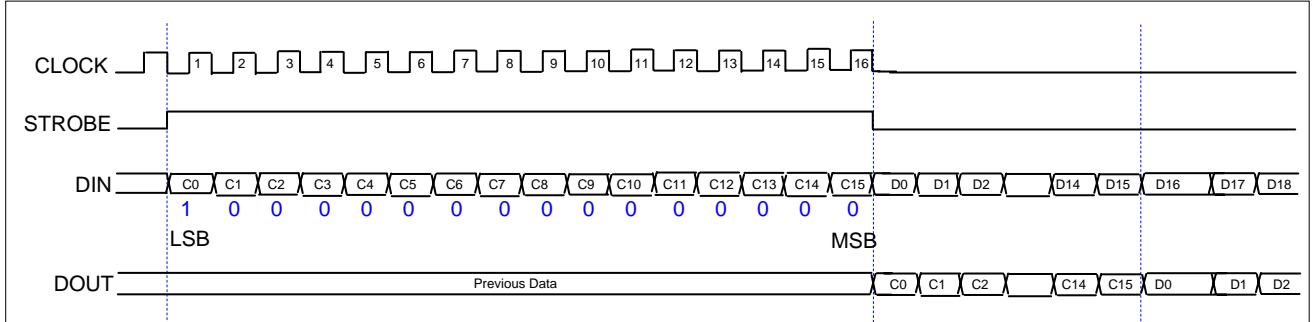
FUNCTIONAL DESCRIPTION

COMMAND TABLE

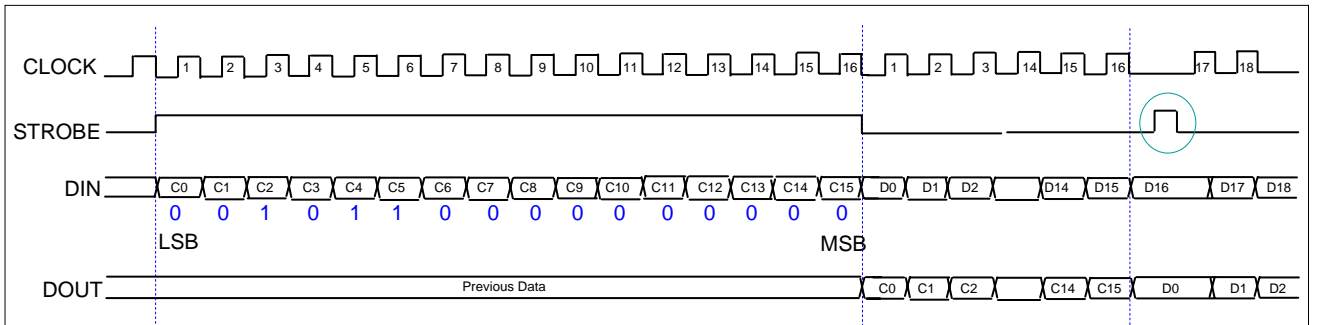
Command Name	Command Value	Description
Software Reset Command	0001h	This command should be issued after power supply input. The Configuration Register, internal shift register, Display Data Register will be cleared with '0' states.
Configuration Register Write Command	0034h	This command is used to update the contents of Configuration Register.
Configuration Register Read Command	0038h	This command is used to read the status of Configuration Register.
Error Status Read Command	003Ch	This command is used to check the 'Open/Short' error status of LED.
Display Data Write Command	0084h	This command is used to write the display image data into LED driver IC for display system.
Global Latch Command	-	This command is used to deliver the internal display data register outputs latched by Display Data Write Command to the internal PWM comparator to make an output current. The Global Latch Command should be transferred after sending the final display data you want. The Global Latch Command has no command value but it needs a special execution sequence.

TIMING DIAGRAM OF COMMAND CONTROL

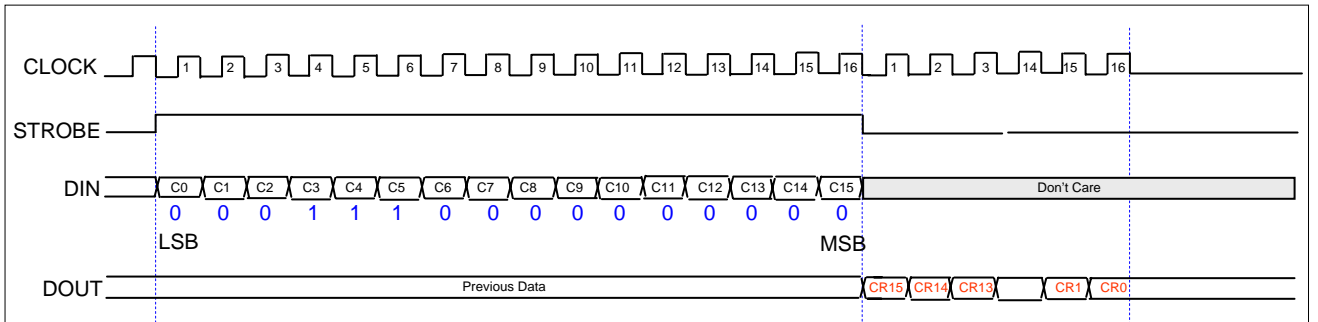
Software Reset Command (0001h)



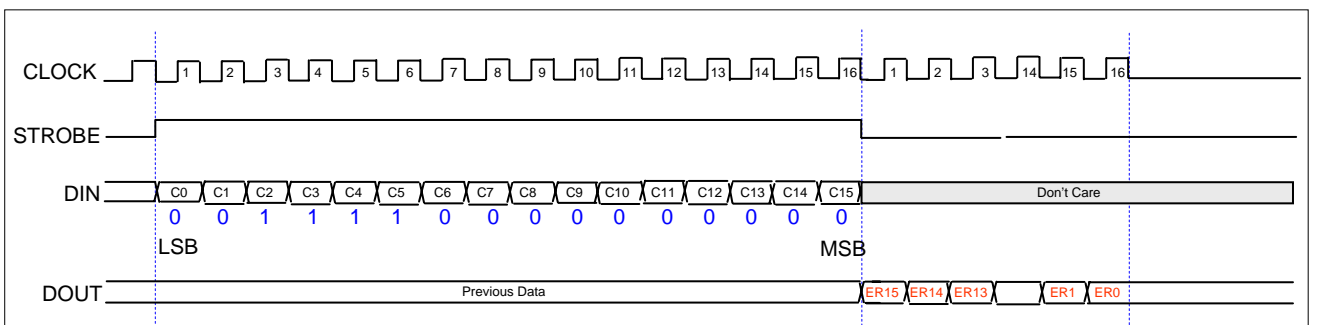
Configuration Register Write Command (0034h)



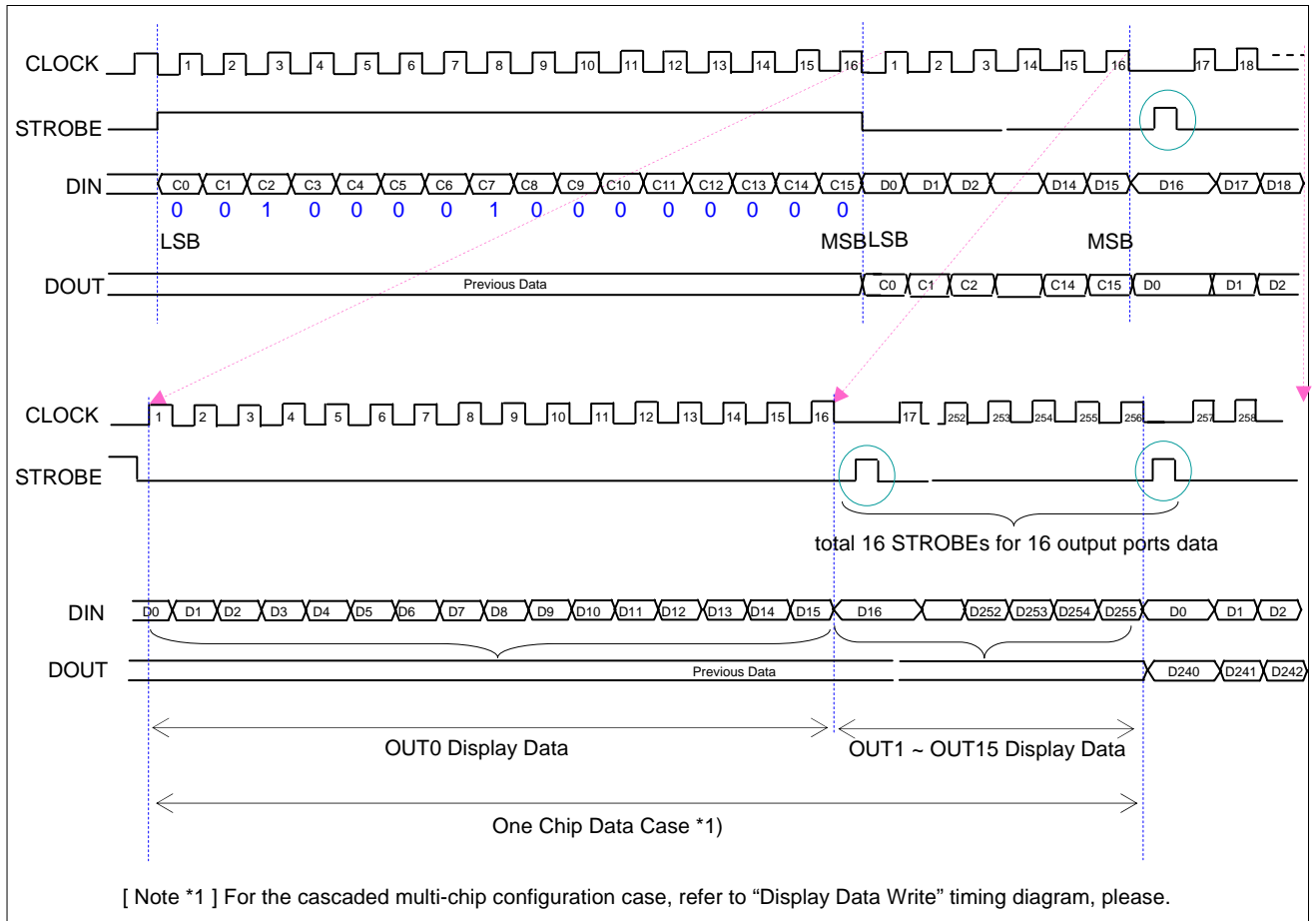
Configuration Register Read Command (0038h)



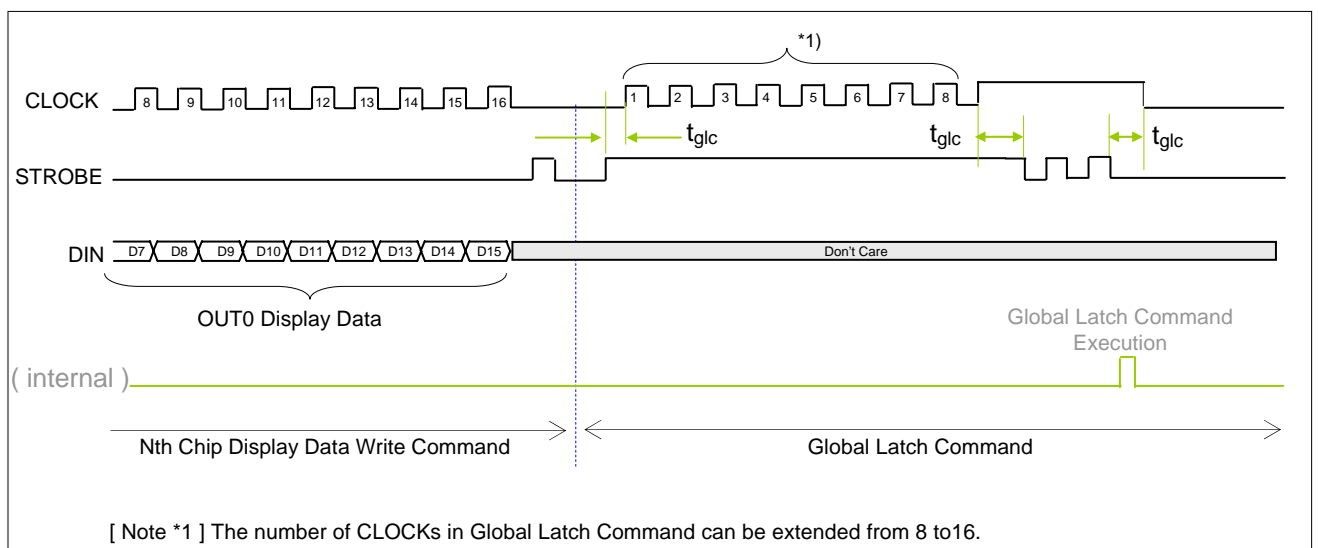
Error Status Read Command (003Ch)

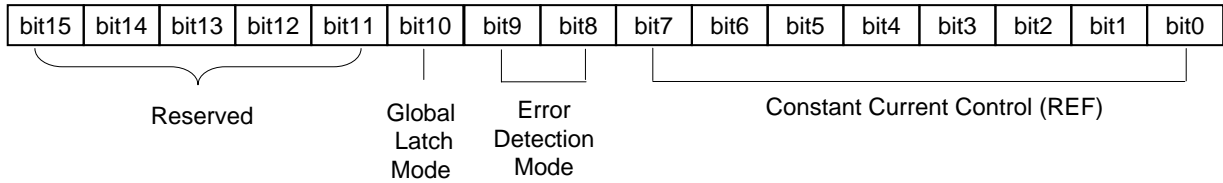


Display Data Write Command (0084h)



Global Latch Command



CONFIGURATION REGISTER (CR[15:0])

Constant Current Control (CR[7:0] Default 00h)

bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	Current Value
0	0	0	0	0	0	0	0	IOUT/256
0	0	0	0	0	0	0	1	IOUT*2/256
-	-	-	-	-	-	-	-	-
0	1	1	1	1	1	1	1	IOUT*128/256
-	-	-	-	-	-	-	-	-
1	1	1	1	1	1	1	0	IOUT*255/256
1	1	1	1	1	1	1	1	IOUT

The IOUT is a constant current of OUTn port which is determined by REXT resistor.

Error Detection Mode (CR[9:8] Default 00b)

bit9	bit8	Error Mode
0	0	Check Disable
0	1	Open Check
1	0	Short Check
1	1	Check Disable

Global Latch Mode (CR[10] Default 0b)

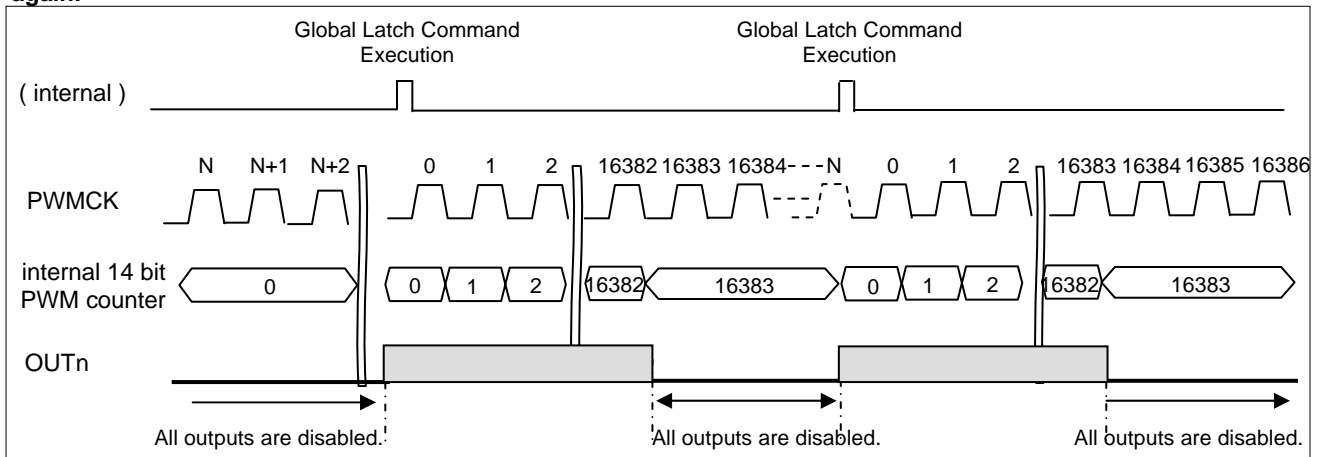
bit10	Global Latch Mode
0	One Shot
1	Automatic Synchronization

SYNCHRONIZATION FOR PWM COUNTING

The LD1071's Global Latch Command supports two kinds of synchronization mode for PWM counting. The default mode is One Shot Mode(Configuration Register bit10=0) and the other mode is Automatic Synchronization Mode(Configuration Register bit10=1).

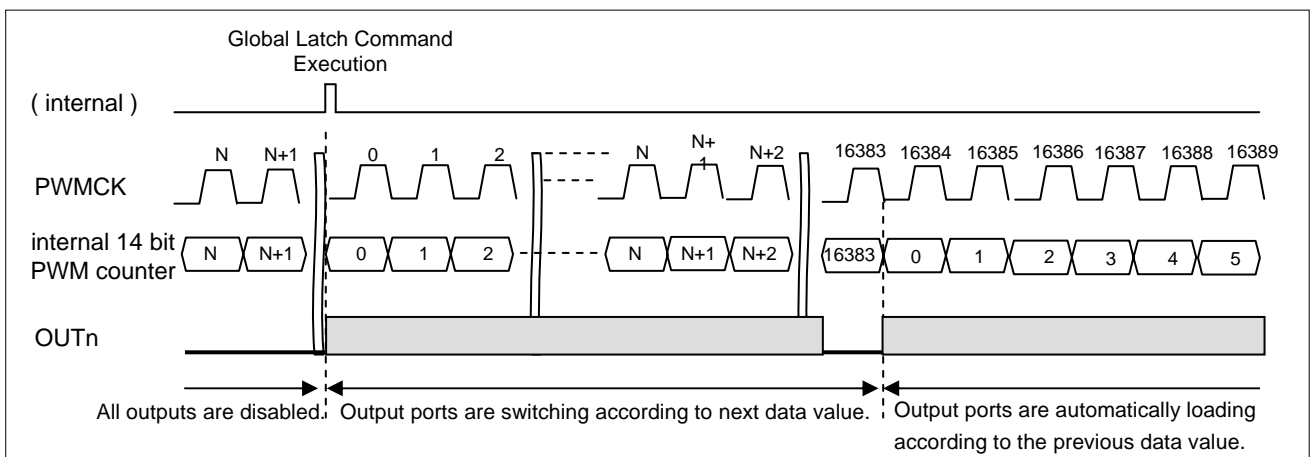
One Shot Mode (Default)

When Global Latch Command is executed in this mode, the LD1071 will update the next image data into output ports immediately, no matter what the counting status of previous image data is. The 14 bit internal PWM Counter is initialized with 0000h and the internal PWM counter starts counting with PWMCK clock. When the internal PWM counter value is reached to FFFFh, the internal PWM counter stops the counting even next PWMCK clock is inputting continuously. As a result, all the outputs will be stopped after finishing one internal PWM display cycle (16384 PWMCK clocks). Only the next Global Latch Command can initialize the counting again.



Automatic Synchronization Mode

When Global Latch Command is executed in this mode(Global Latch Mode=1), the LD1071 will update the next image data into output ports immediately, no matter what the counting status of previous image data is. When the internal PWM counter value is reached to FFFFh, if there is no Global Latch Command, the LD1071 automatically loads the previous image data into output ports at next 16384th PWMCK clock again. So in this mode, output ports will be automatically updated at every 16384 PWMCK clocks with previous data.



WRITING THE DISPLAY DATA

With the 16 bit data, all output ports can be built with 16,384 gray scales. The 16-bit input shift register latches 16 times of gray scale data into each data buffer with Display Data Write Command sequentially . Finally Global Latch Command will load the 256 bit internal data buffers with LSB first into from output port 15(OUT15) to output port 0(OUT0). Even 16 bit display data for each port should be transferred, only 14 bits data are valid for gray scale image (bit[13:0]) and the high 2bits(bit[15:14]) are reserved. For the detail timing and sequence, refer to “Display Data Write Command” and “Global Latch Command” which is described on page 14, please.

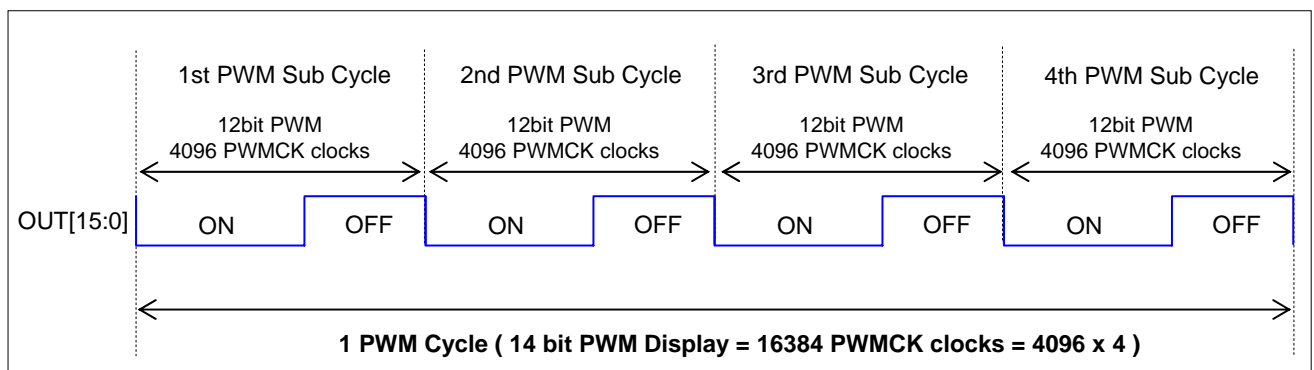
PWM DISPLAY CYCLE

The LD1071 implements the 14 bit gray level of each output port using the 4 PWM sub cycles. Each PWM sub cycle is consisted of 12 bit PWMCK clocks. This enhancement provides a excellent energy distribution in lighting the LED and increases the visual refresh rate and reduces the flickers.

- D[15:14] : Reserved
- D[13:0] : Display Data(14 bit Gray Scale Data)

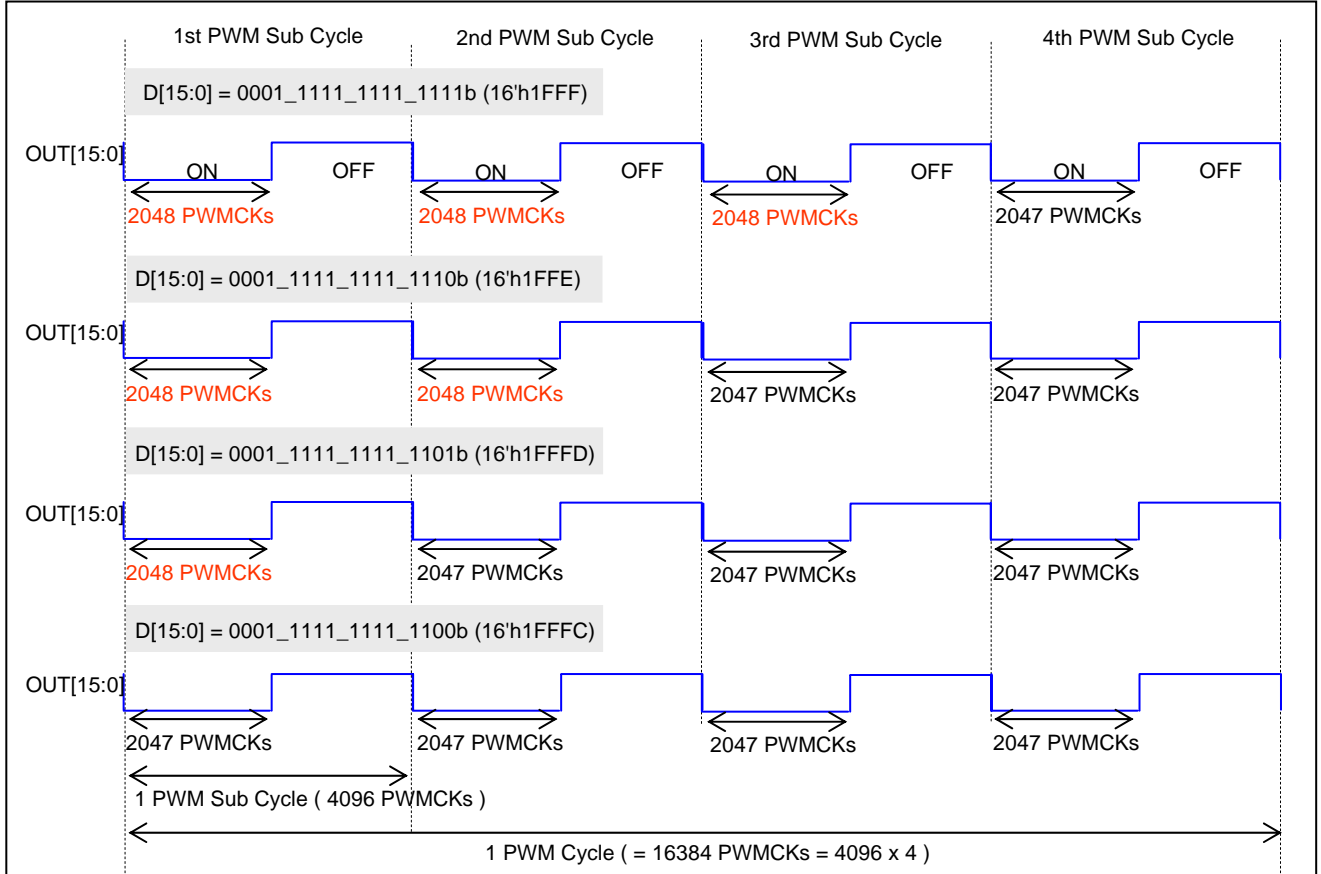
- bit[13:2] : 12bit PWM Comparing Data

- bit[1: 0] : PWM Insert data
 - 1 1 : one pulse is inserted in 1st, 2nd and 3rd PWM Sub Cycle
 - 1 0 : one pulse is inserted in 1st and 2nd PWM Sub Cycle
 - 0 1 : one pulse is inserted in 1st PWM Sub Cycle
 - 0 0 : Not inserted

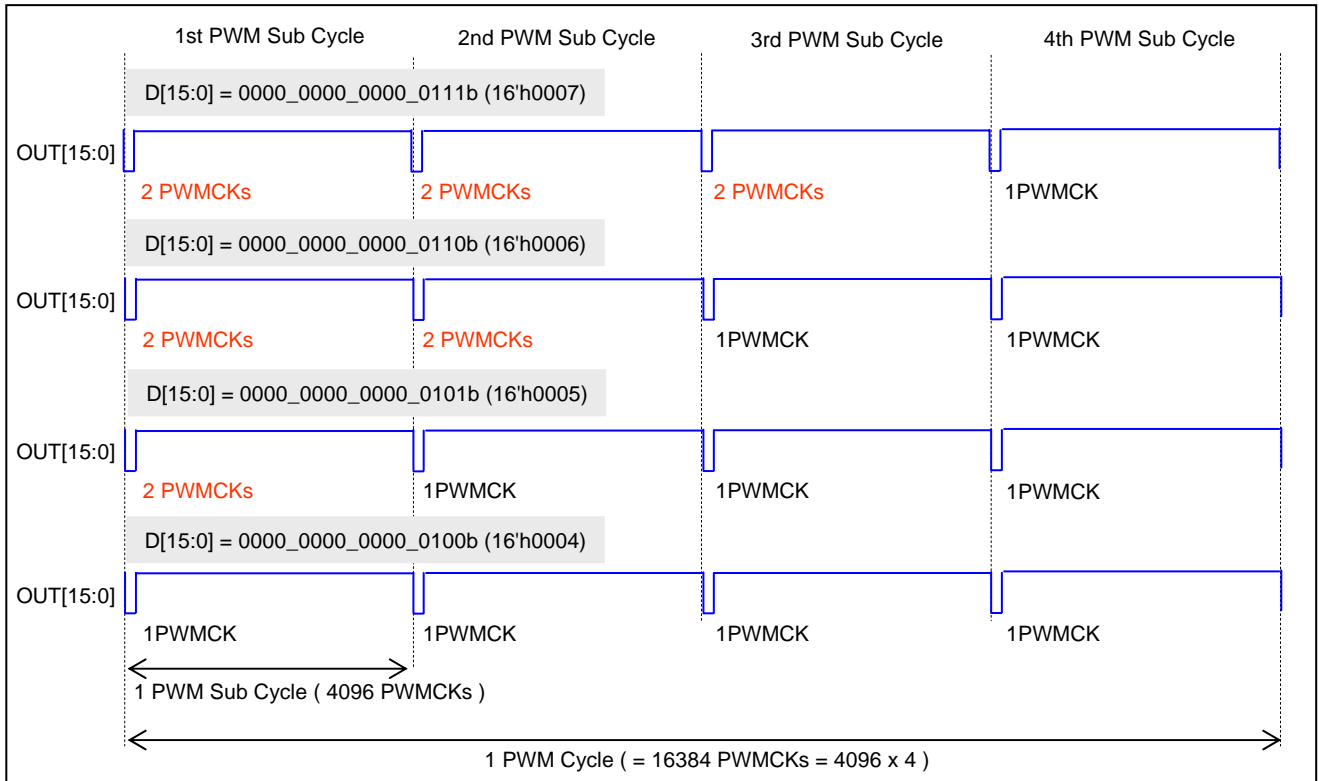


The following examples show the PWM timing diagram for different display data.

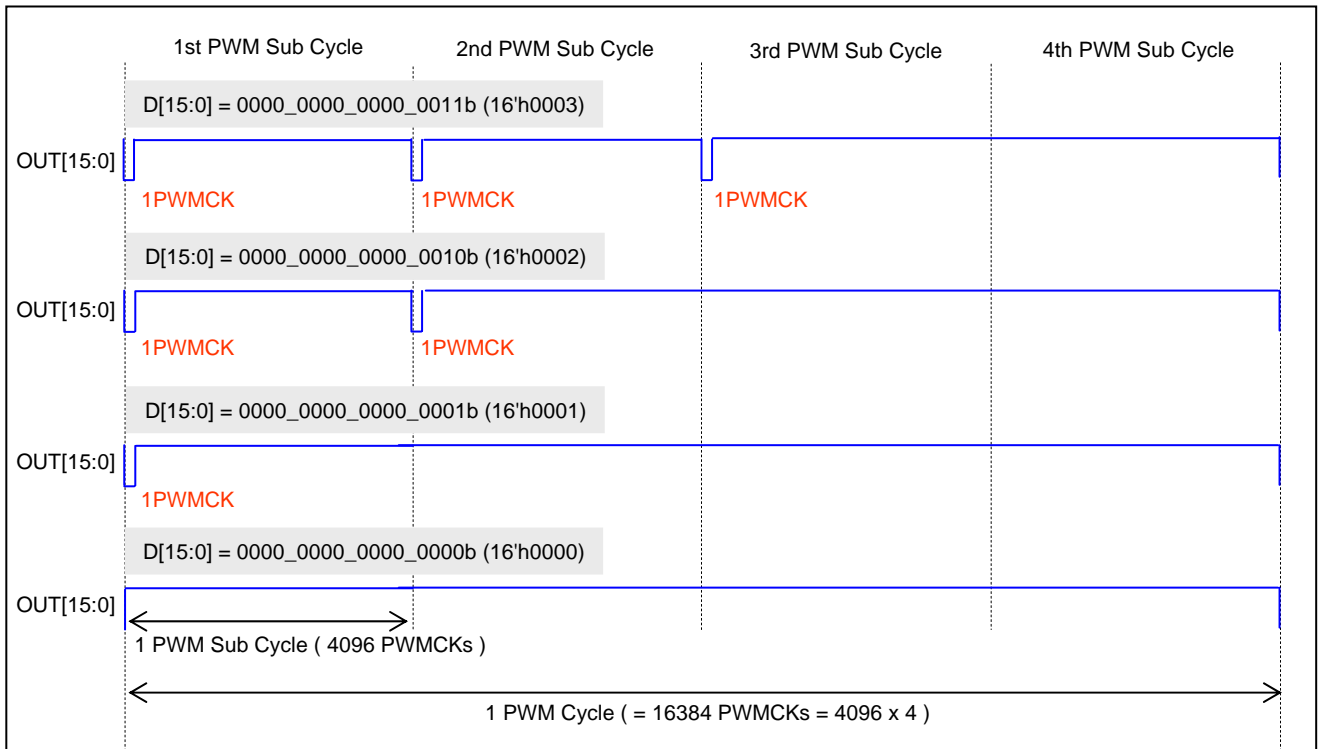
(Case 1)



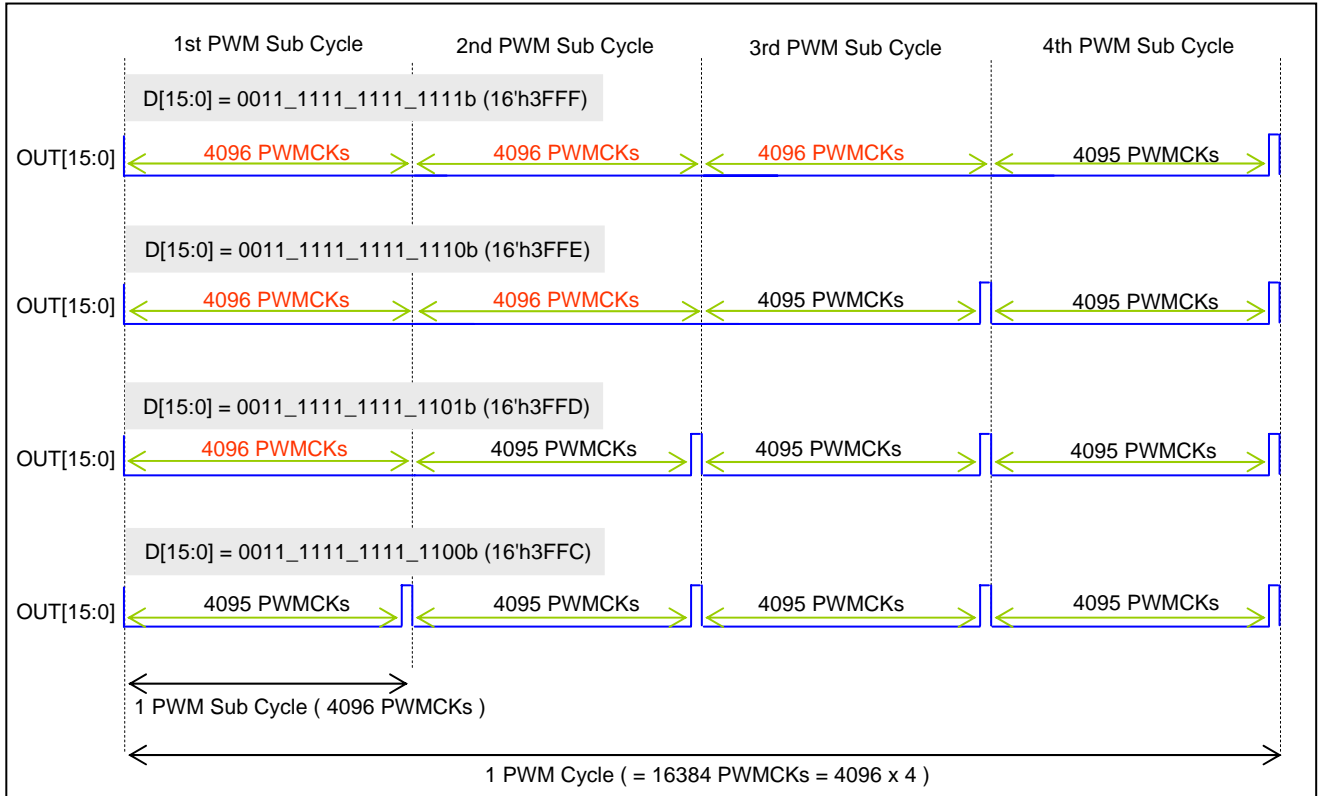
(Case 2)



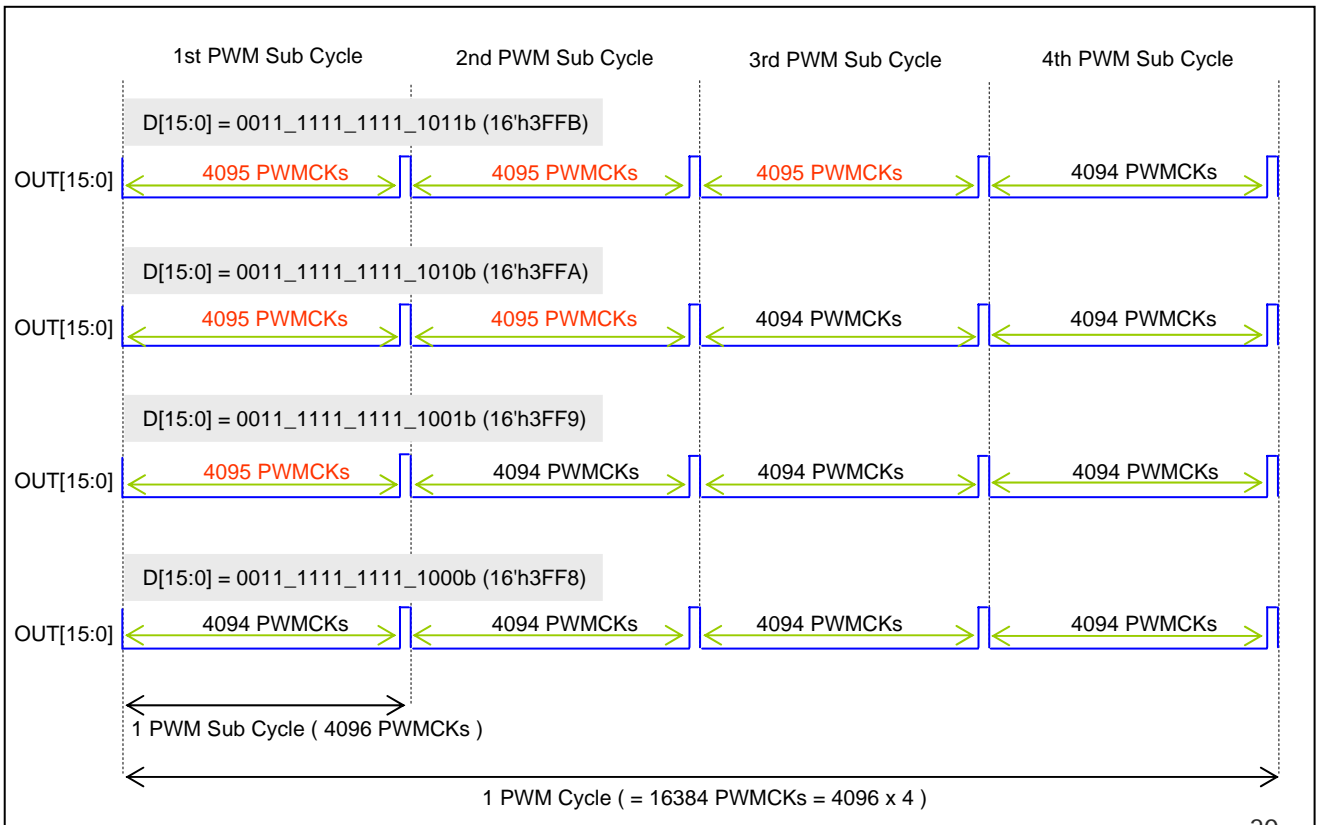
(Case 3)



(Case 4)



(Case 5)



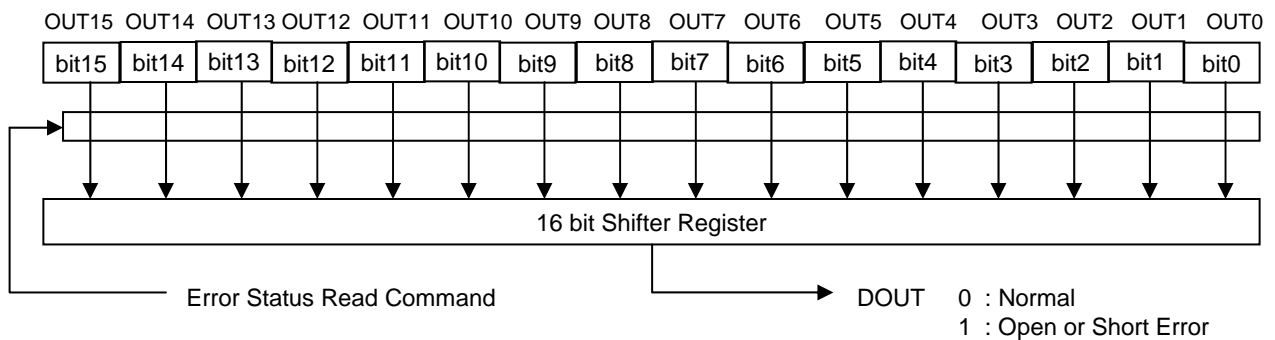
ERROR DETECTION

The LD1071 will be able to detect the error status of LED such as open/short error. This function can be entered by setting the bits of Error Detection Mode(CR[9:8]) as 01b(Open Detection) or 10b(Short Detection). The correct meaning of error is defined as follows;

- Open Error : Output port(OUTn) is not connected to LED.
- Short Error : Output port(OUTn) is shorted to GND.

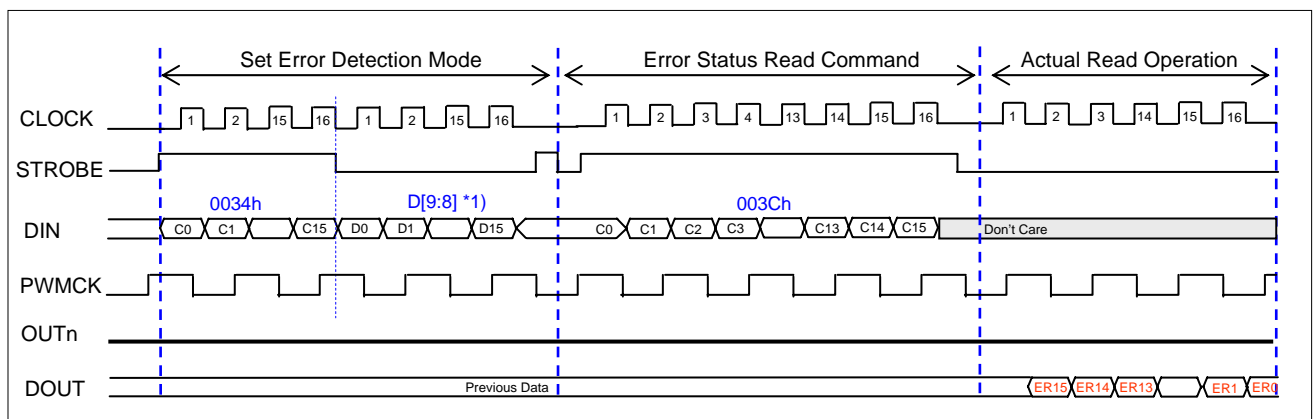
Error Detection Code			
	Output Port status	Error Detection Voltage	Meaning
Open Check	OFF	OUT Voltage > 0.8V	Normal
		OUT Voltage < 0.8V	Open Error
Short Check	OFF	OUT Voltage > 0.8V	Normal
		OUT Voltage < 0.8V	Short Error

Error Status Register (ER[15:0])

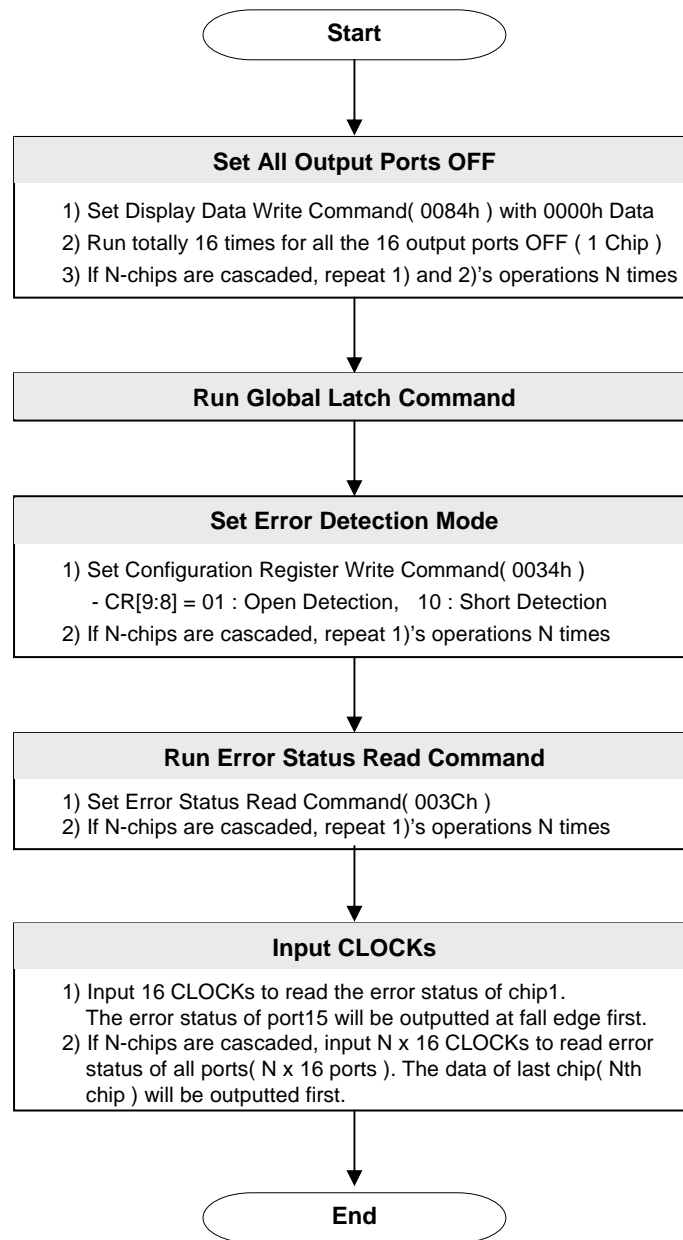


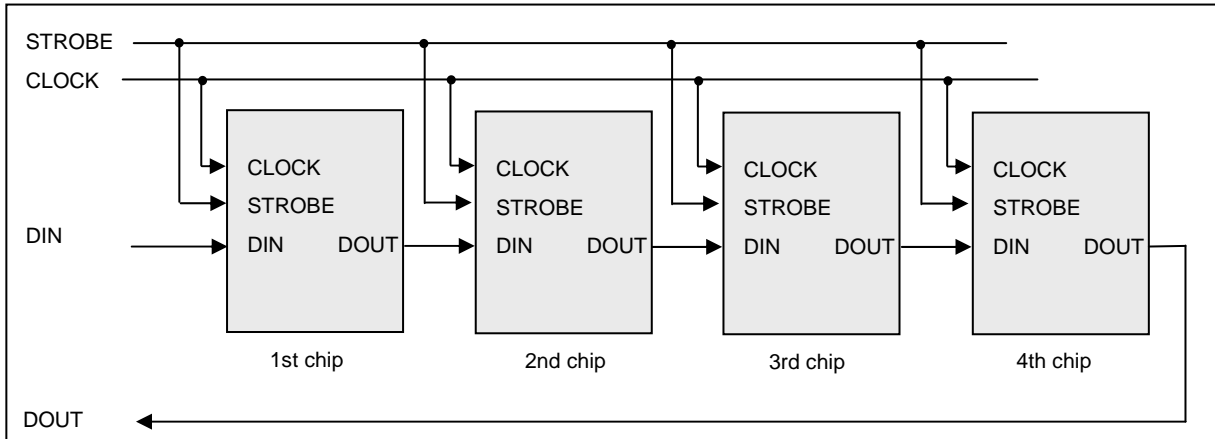
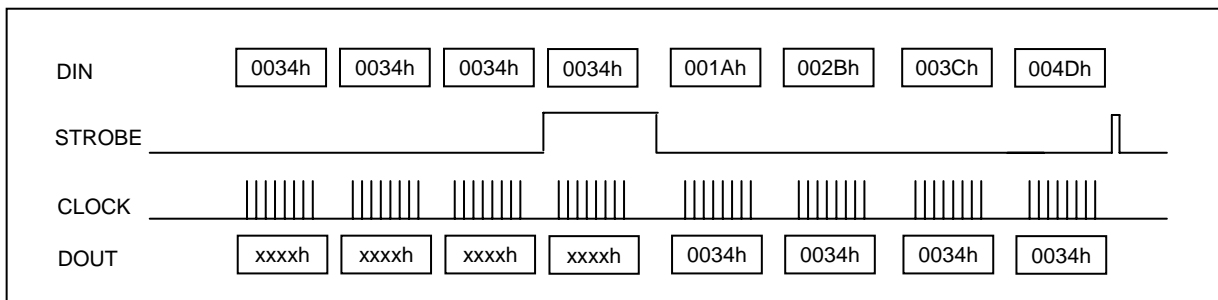
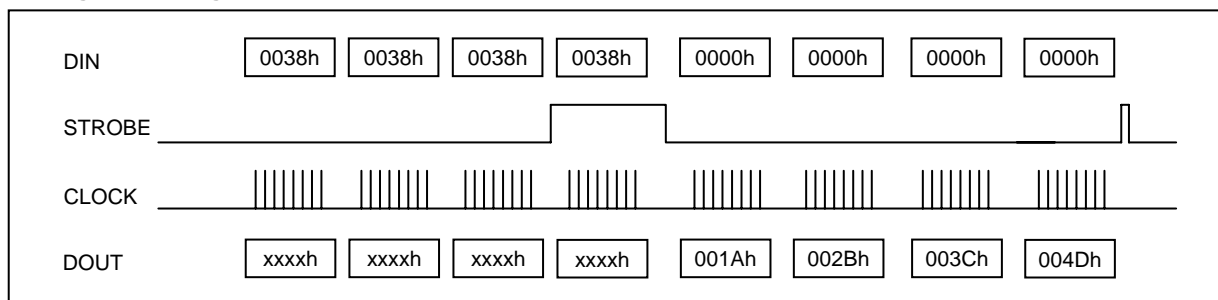
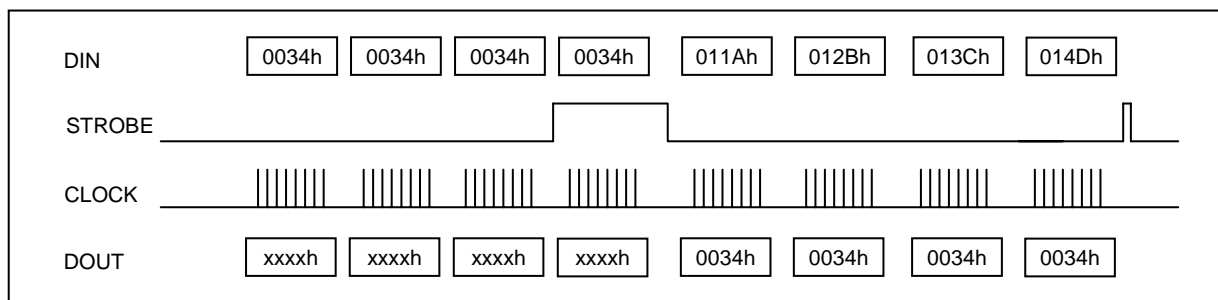
Timing Diagram of Error Status Check

The next timing diagram shows the sequence of error status read operation. The actual error status is read with MSB first after execution of Error Status Read Command. First of all, in order to read the error status, all the output ports (OUT15~OUT0) should be off. So you need some pre-processing for error status read. The flow chart will be provided on next page.

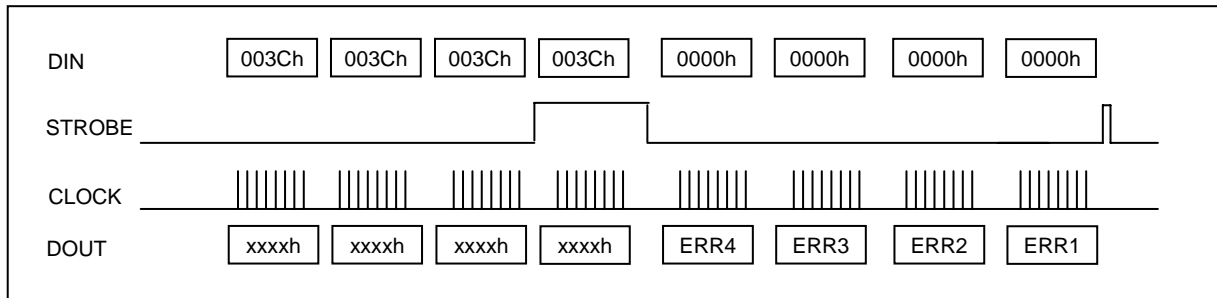


Note *1) In order to keep the Constant Current Value(CR[7:0]) and Global Latch Mode(CR[10]) correctly, maybe you need to read the Configuration Register through the Configuration Register Read Command(0038h) prior to set Error Detection Mode.

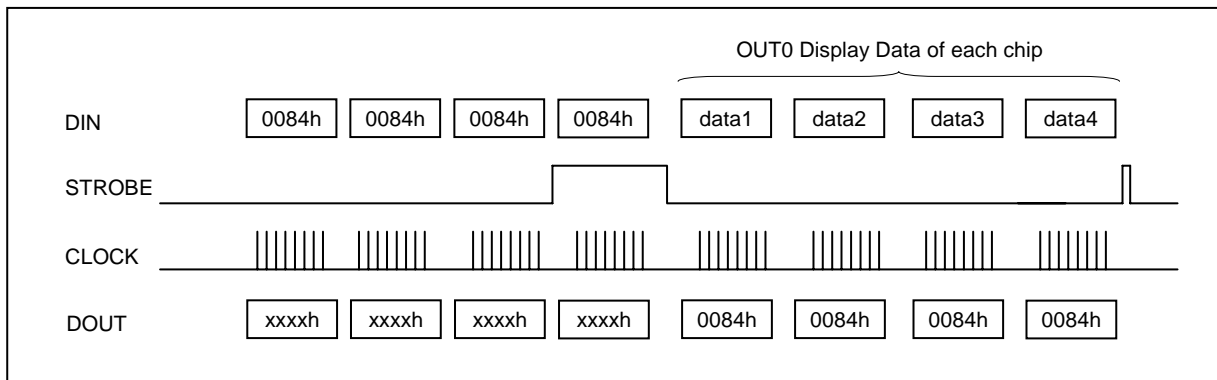

Flow Chart of Error Status Check

COMMAND SETTING GUIDE FOR MULTI-CHIP CASCADE CONFIGURATION

Configuration Register Write(Current Control)

Configuration Register Read

Configuration Register Write (Error Detection Enable)


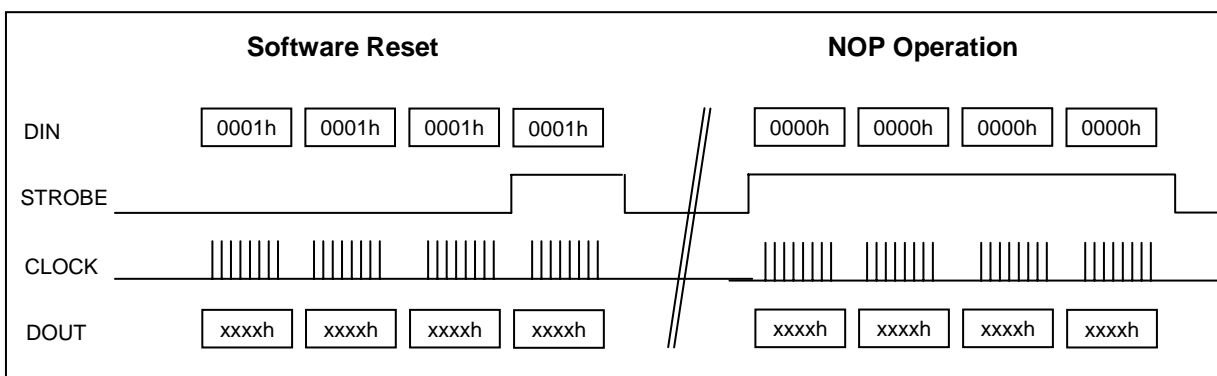
Error Status Read

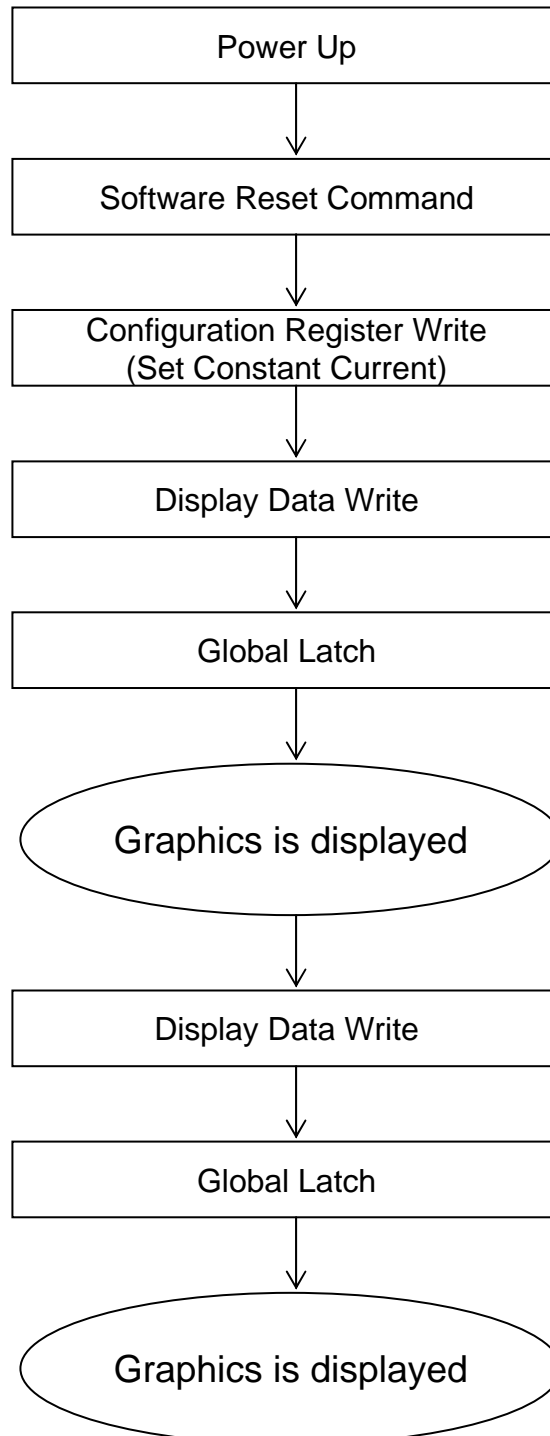


Display Data Write



Software Reset & NOP Operation



RECOMMENDATION OF GLOBAL SEQUENCE


The first command should be issued after 0.1ms from Power-Up.

SETTING OUTPUT CURRENT

The output current is determined by an external resistor. The relationship between I_{OUT} and R_{EXT} is as follows;

When VDD = 5V

$$I_{OUT}[A] = \{1.06/(120+R_{EXT})\} * S * 61.4$$

where $S = (REF+1)/512$

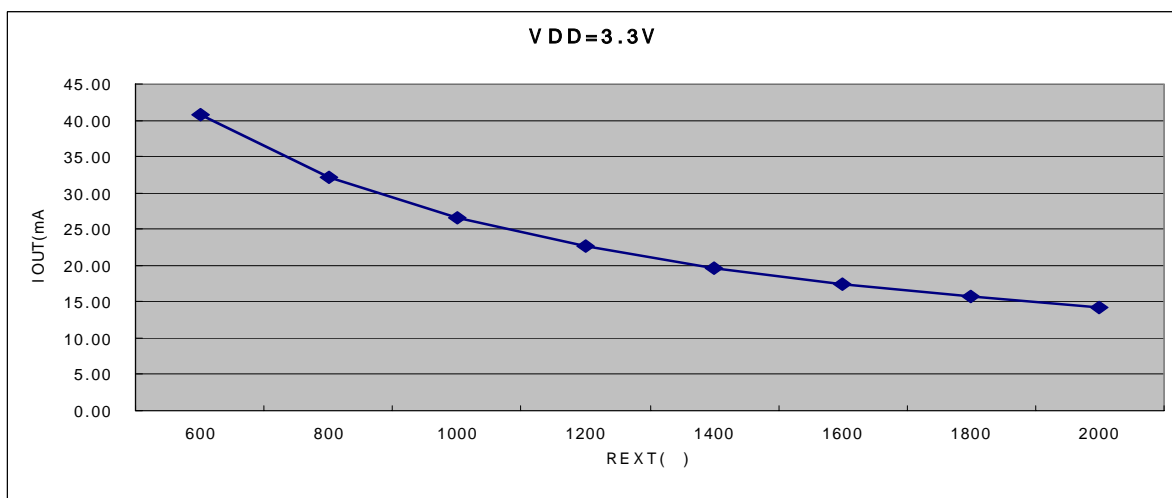
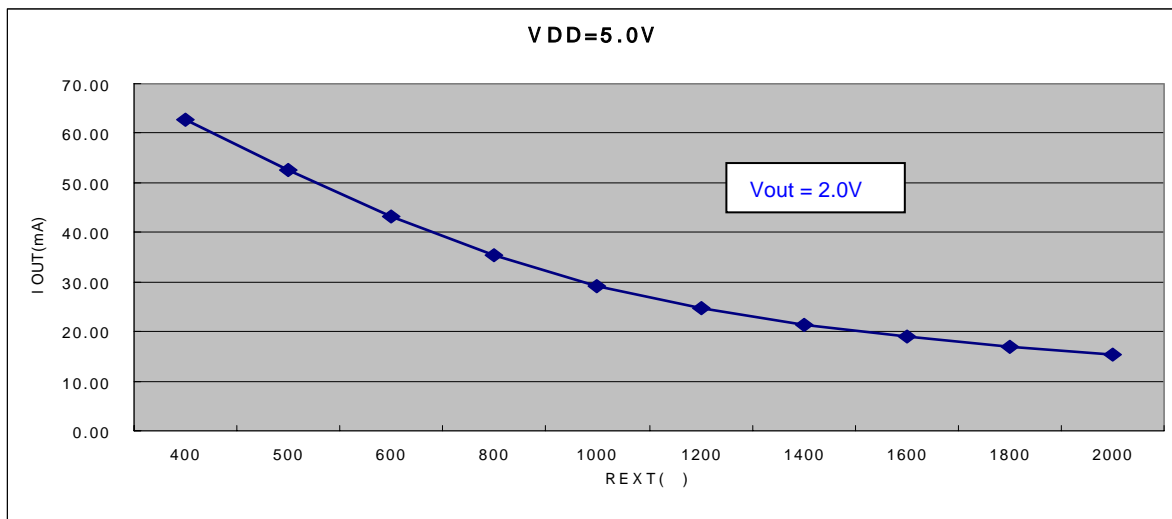
When VDD = 3.3V

$$I_{OUT}[A] = \{1.06/(150+R_{EXT})\} * S * 57.6$$

where $S = (REF+1)/512$

- R_{EXT} : External Resistor[Ω]
- REF : Constant Current Control (0 ~ 255, CR[7:0] of Configuration Register)

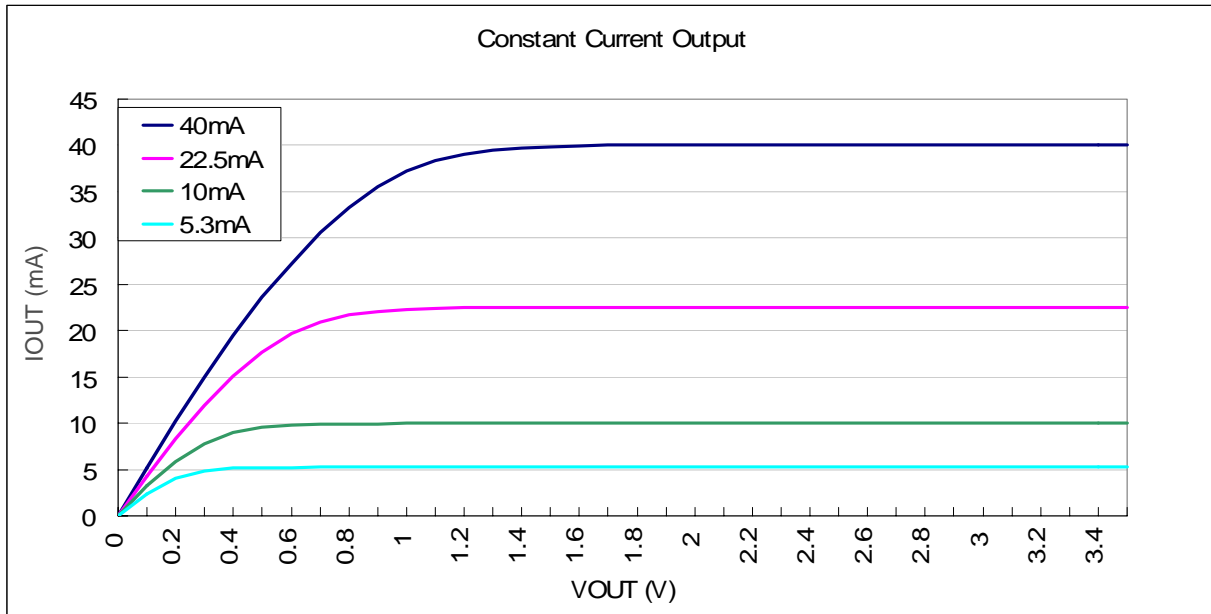
Because the default REF value(CR[7:0]) of Configuration Register(0034h) for current control is 00h, if you want to set the output current through changing the REXT value with following graph, do not forget to write the CR[7:0] of Configuration Register with 'FFh', please.



[Note] When VDD is 3.3V, in order to guarantee the accurate output current, do not set the I_{OUT} to over 40mA, please.

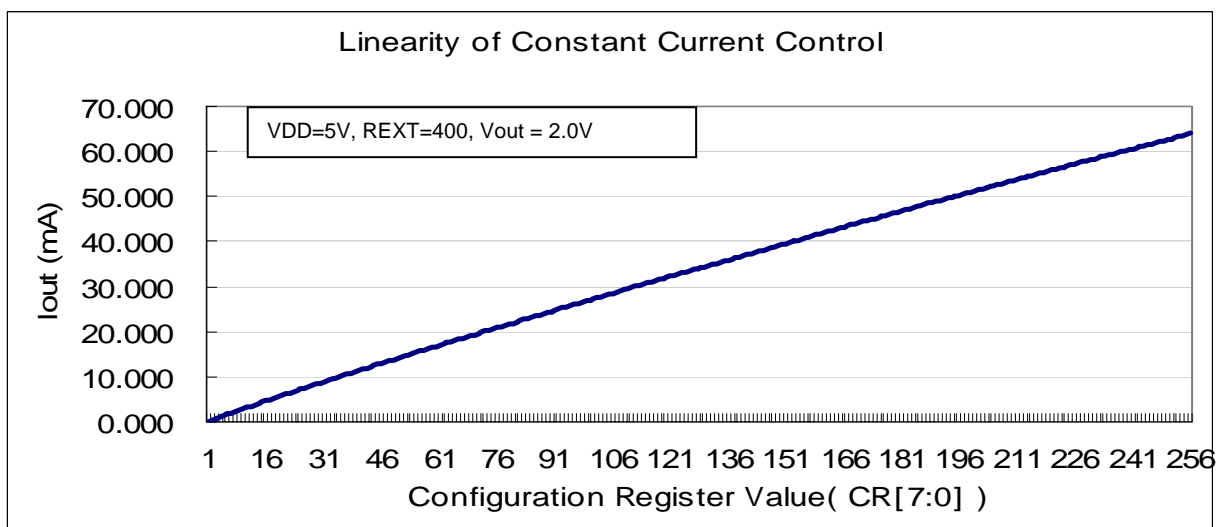
CONSTANT OUTPUT CURRENT

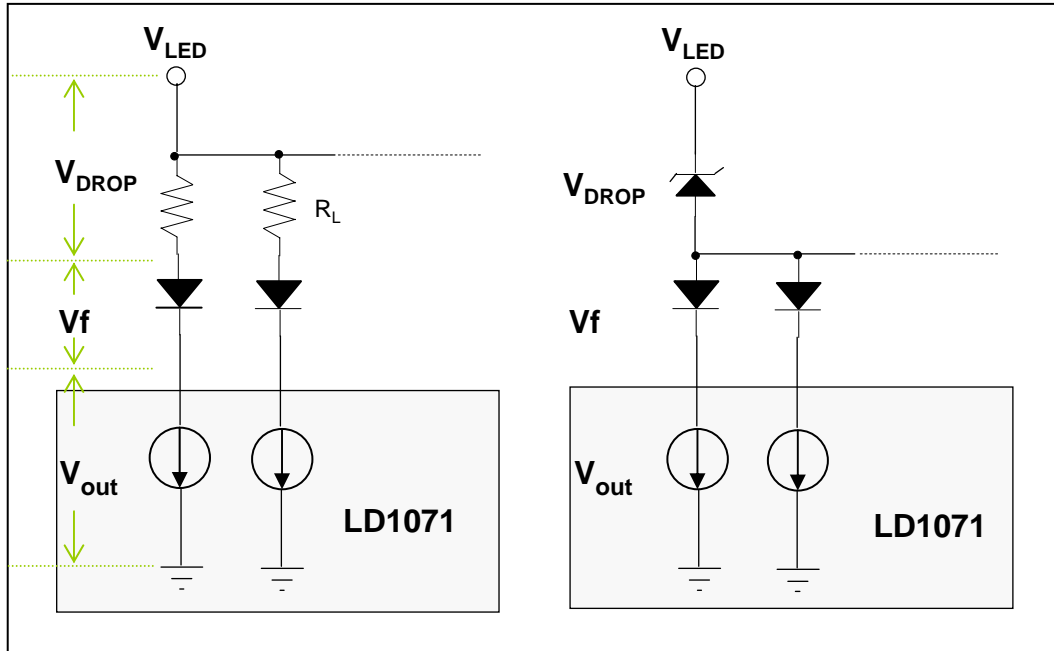
The LD1071 provides a constant current output characteristics for LED display application. The pin to pin deviation is max +/- 3% and chip to chip deviation is max +/- 6%.



CONSTANT CURRENT CONTROL

The LD1071 provides a excellent Iout linearity by setting the Configuration Register for global brightness control. The following graph shows the linearity example under the condition at VDD=5V, REXT=400 ohms and Vout = 2.0V.



LED SUPPLY VOLTAGE(VLED)


It is very important to select the proper value of Load Resistor(R_L). Because the optimal V_{OUT} value guarantees the constant output current and long life time of LED driver IC without over power consumption.

For example, let's calculate the Load Resistor value at $V_{LED}=5V$, $I_{out}=20mA$, LED Forward Voltage(V_f)= $3V$.

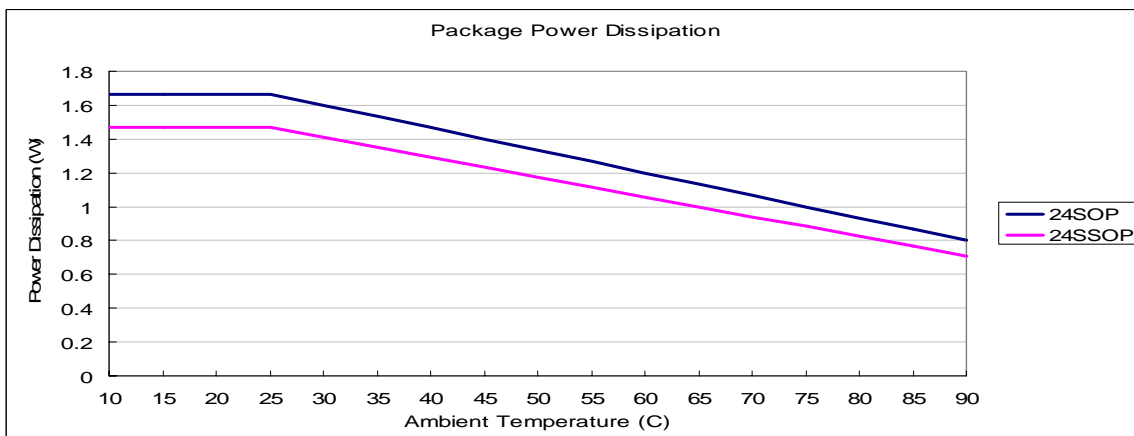
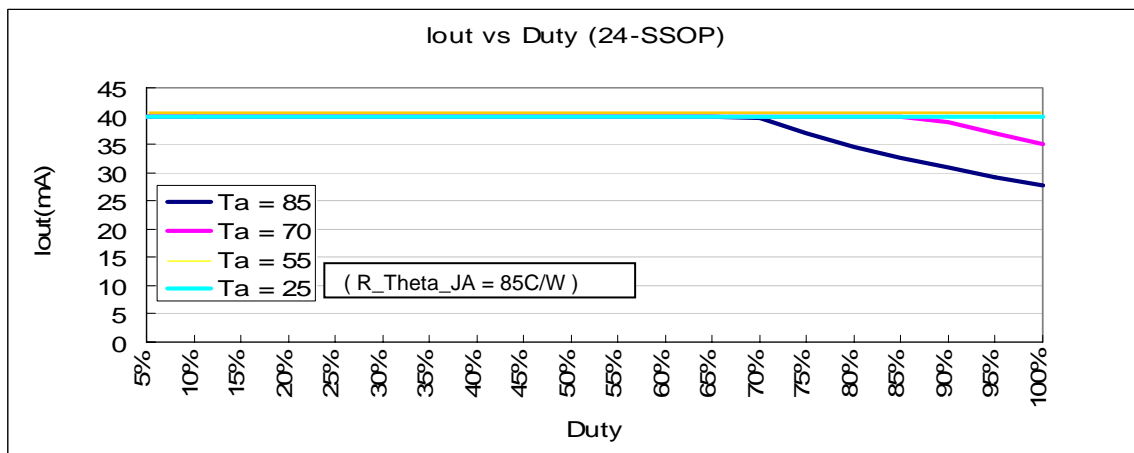
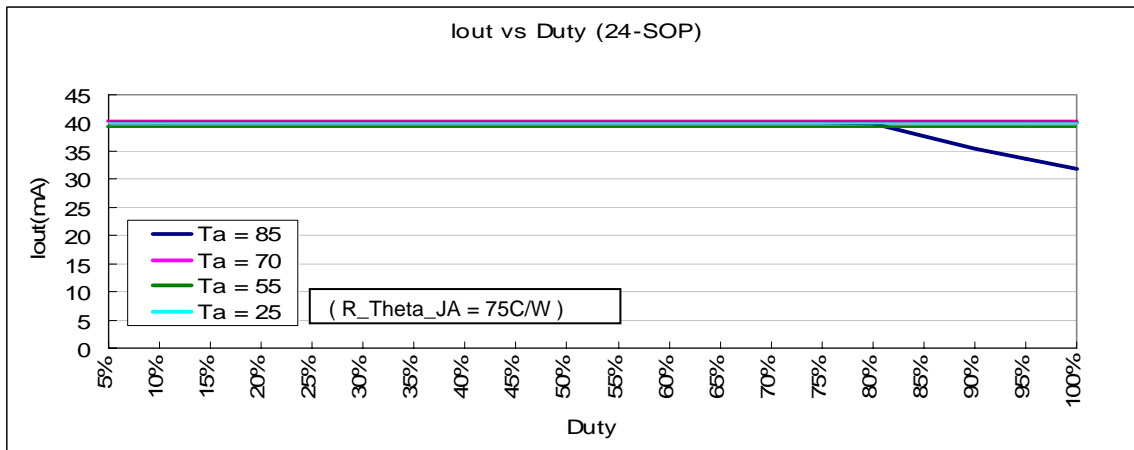
- 1) The full current of LD1018 = $20mA \times 16$ (channels) = $320mA$
- 2) The power consumption is $320mA \times V_{OUT}$ voltage.
 - when $V_{OUT} = 1V$, the power consumption is $320mW$.
 - when $V_{OUT}= 2V$, the power consumption is $640mW$.

$$\begin{aligned}
 \text{Therefore, the Load Resistor } (R_L) &= (V_{LED} - V_{OUT} - V_f) / I_{out} \\
 &= (5V - V_{OUT} - 3V) / 20mA \\
 &= \underline{40} \text{ (When } V_{OUT} = 1.2V)
 \end{aligned}$$

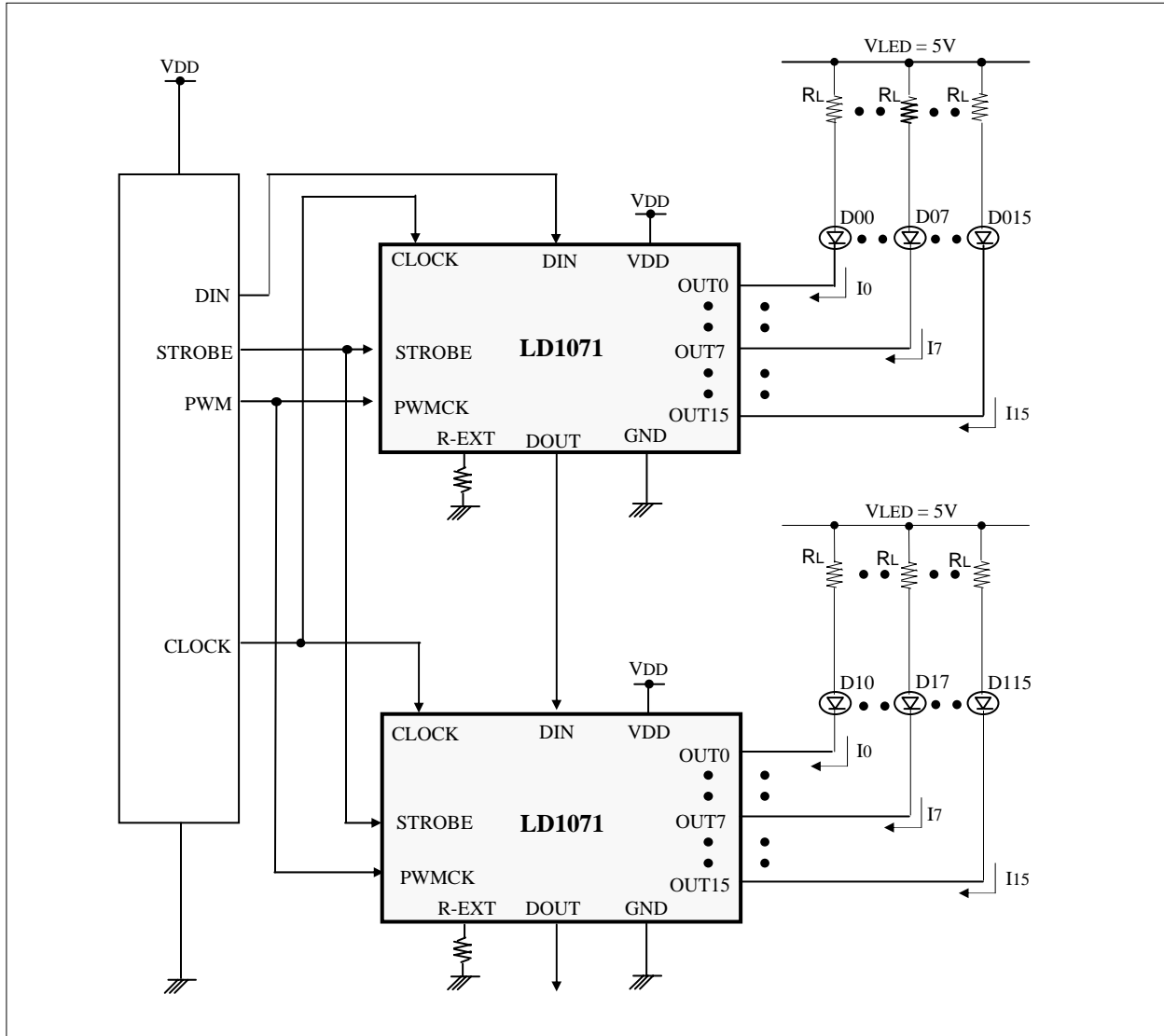
PACKAGE POWER DISSIPATION(PD)

The LD1071 provides many package options such as 24-SOP package and 24-SSOP package. The maximum allowable package power dissipation is determined as $PD(max) = (T_j - T_a) / R_{\theta JA}$. When 16 output ports are turned on simultaneously, the actual power package dissipation is $PD(act) = (I_{DD} \times V_{DD}) + (I_{OUT} \times Duty \times V_{OUT} \times 16)$. Therefore, to keep that $PD(act)$ is less equal than $PD(max)$. The maximum allowable output current as a function of duty cycle is:

$$I_{OUT} = \{[(T_j - T_a) / R_{\theta JA}] - (I_{DD} \times V_{DD})\} / V_{OUT} / Duty / 16 \quad \text{where } T_j = 150C$$

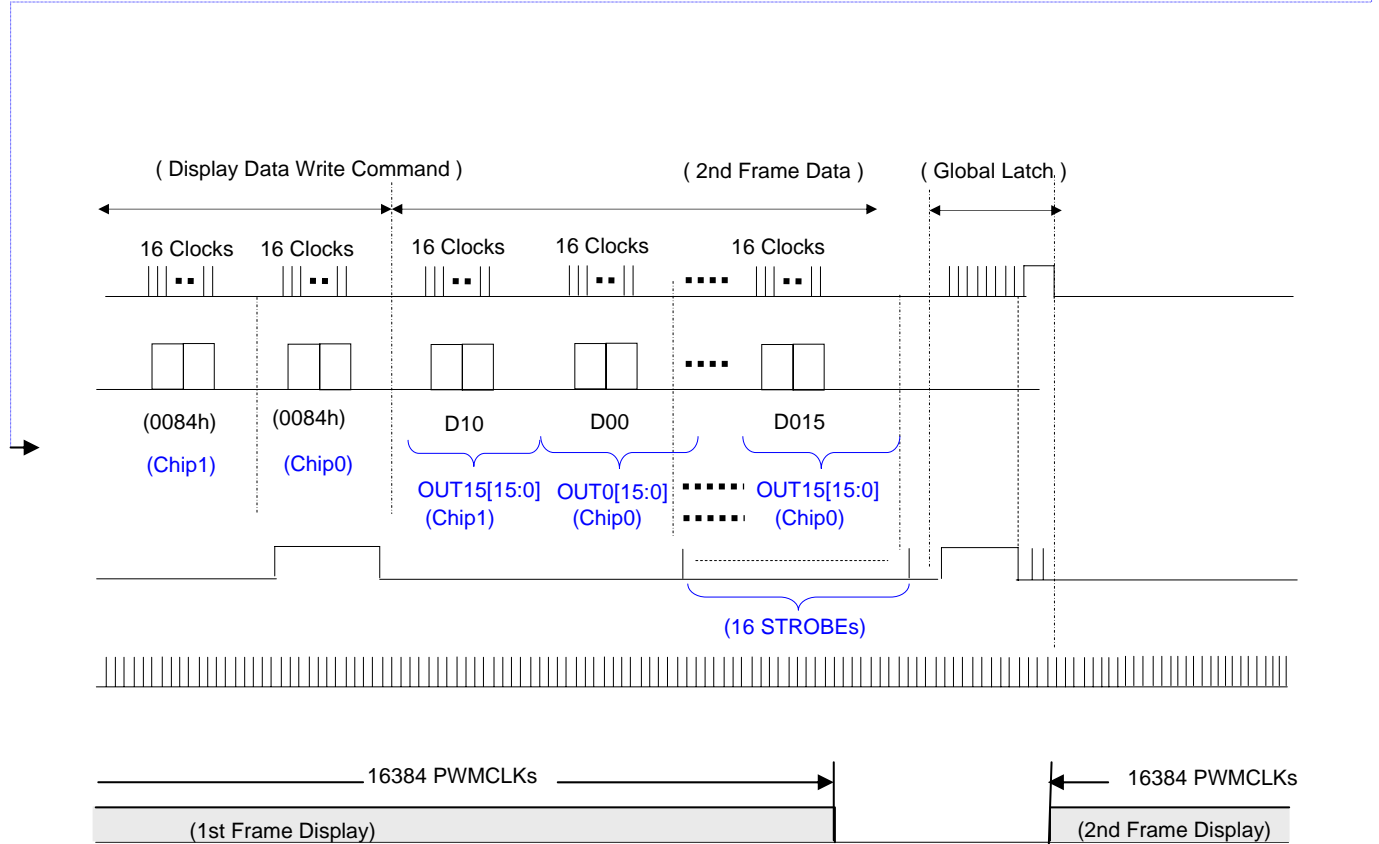
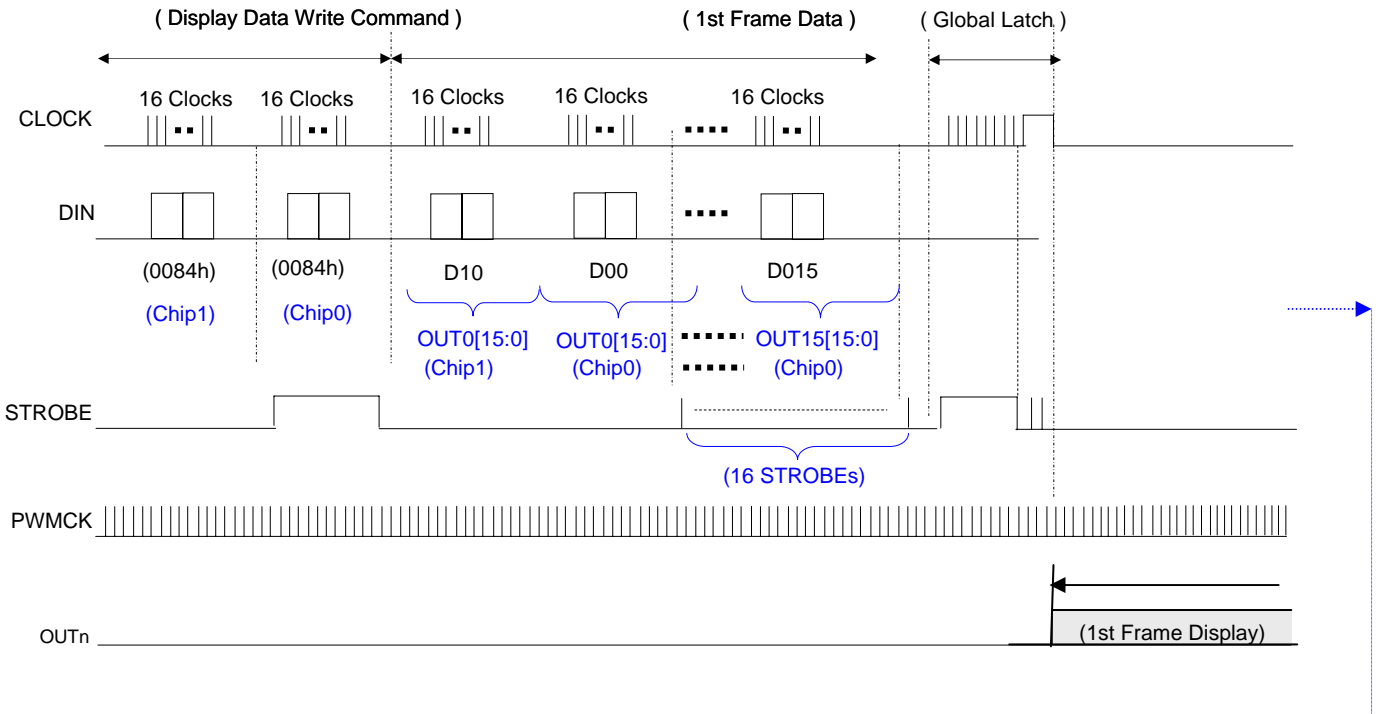


APPLICATION CIRCUIT 1 (16x2 Static Type)

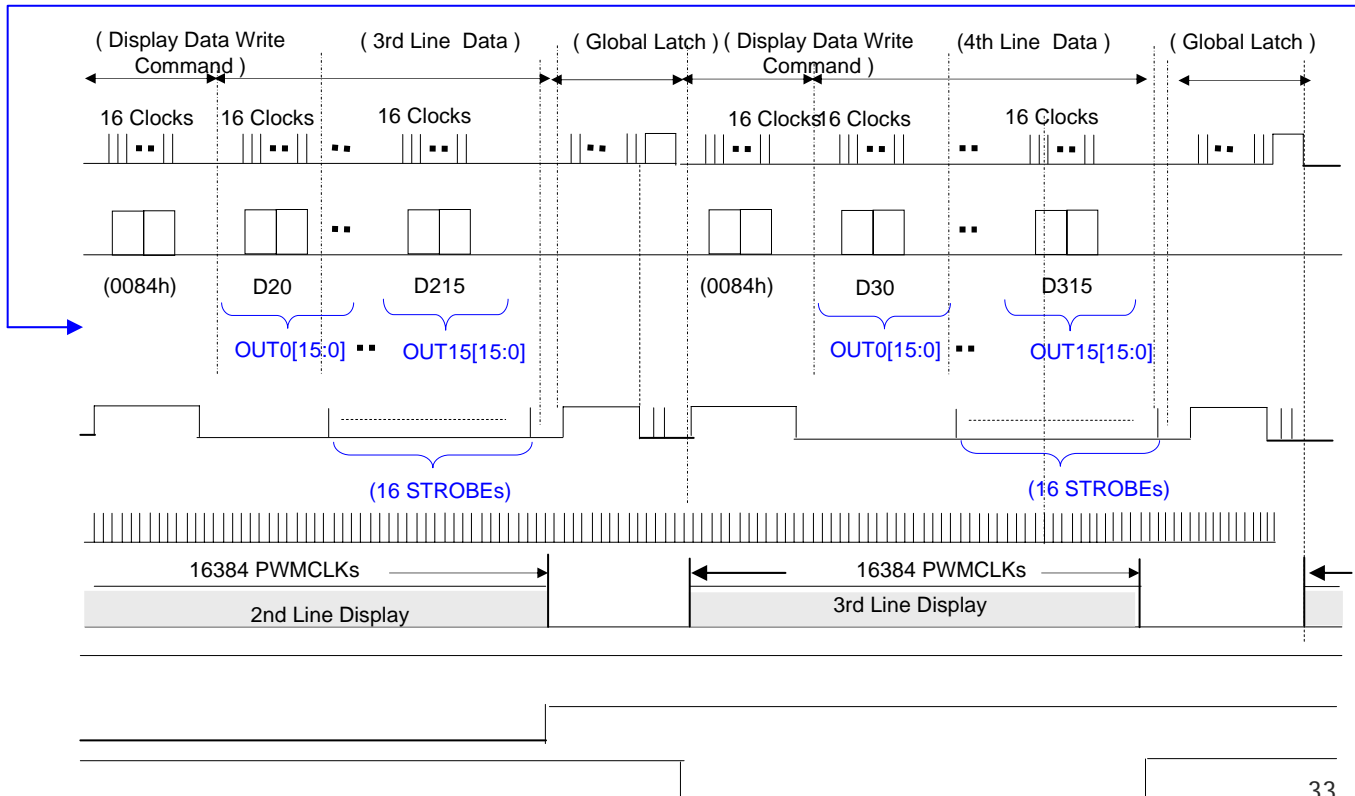
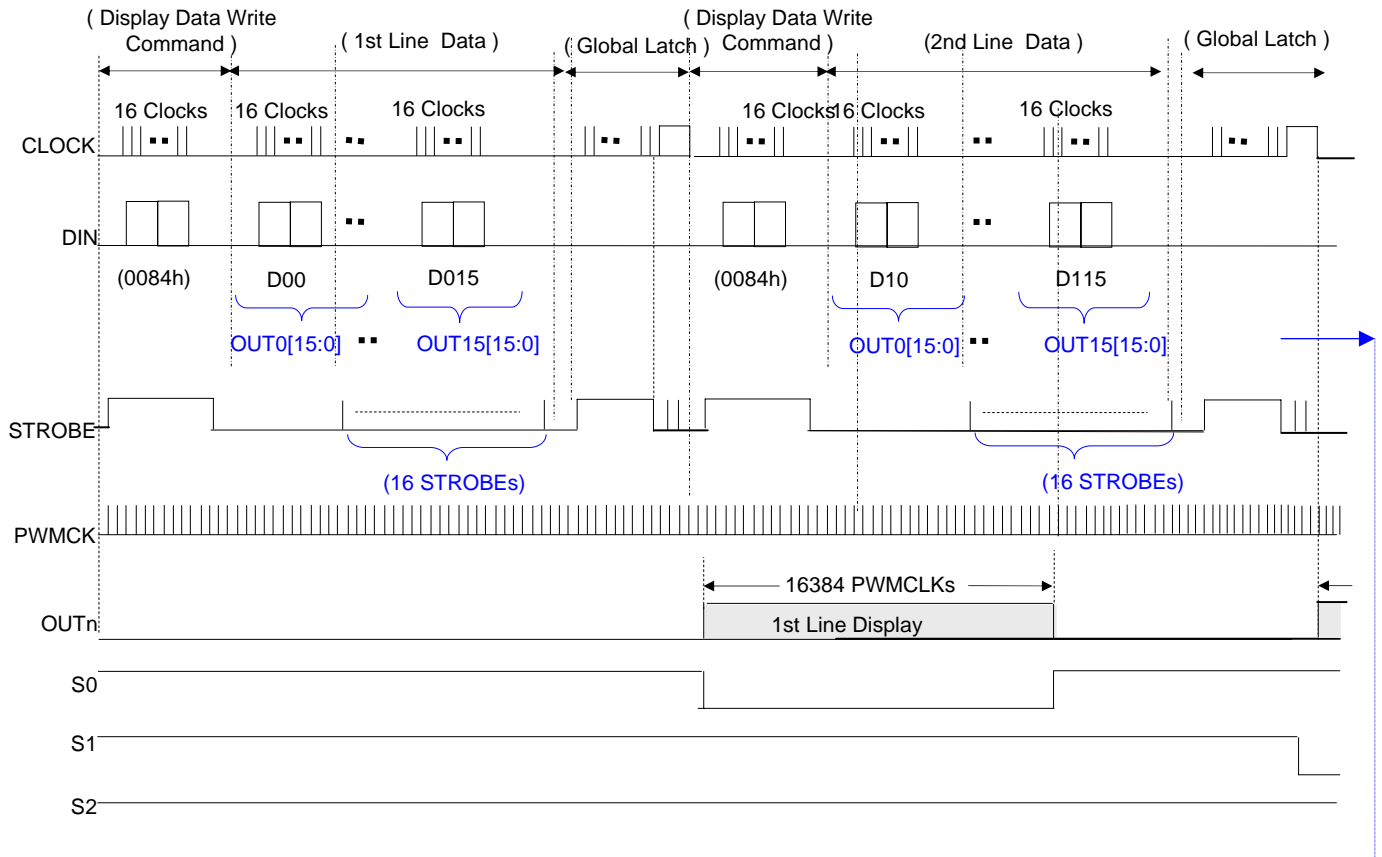


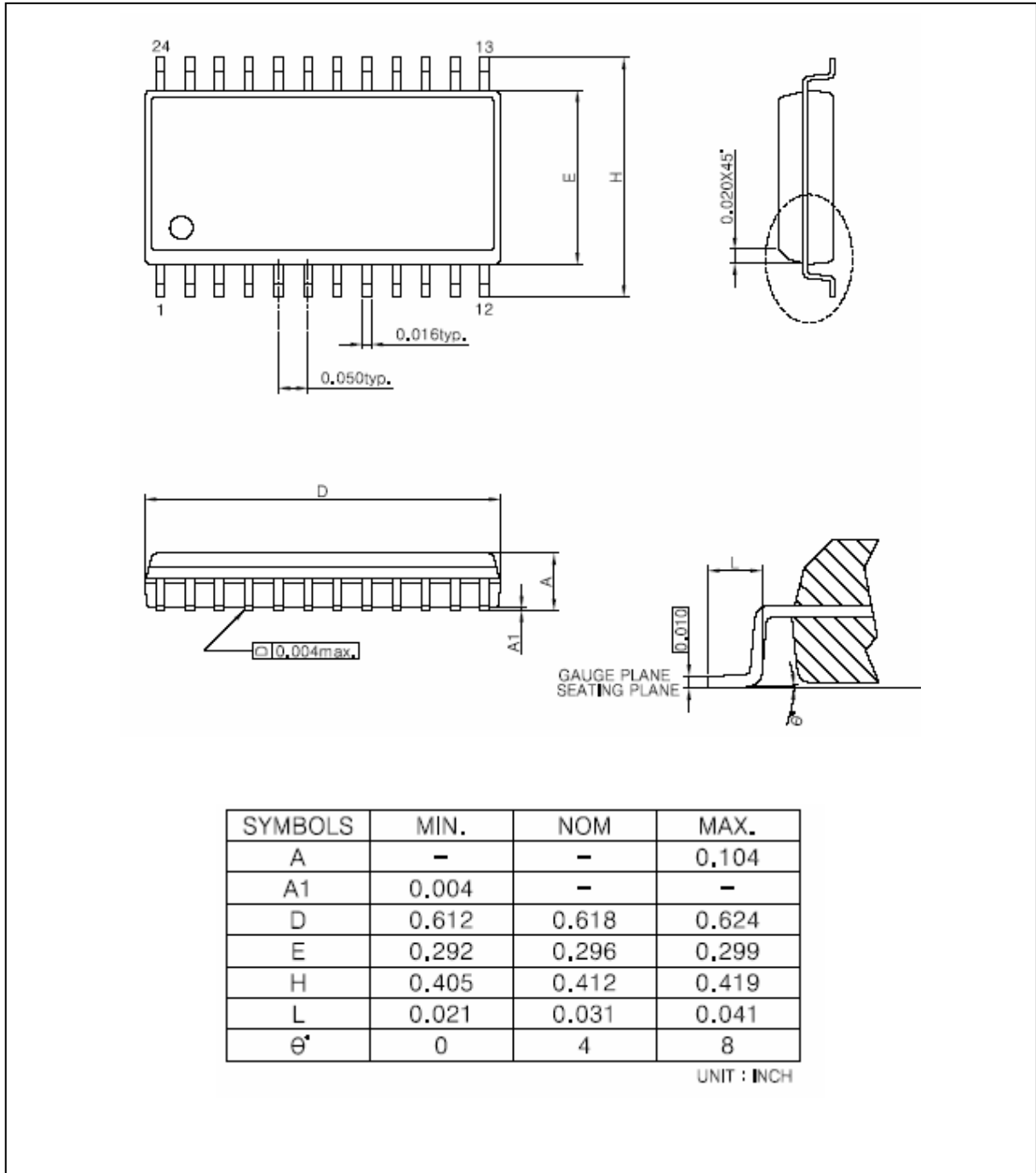
Data & Control Signal Connection for 16x2 Static Type Application

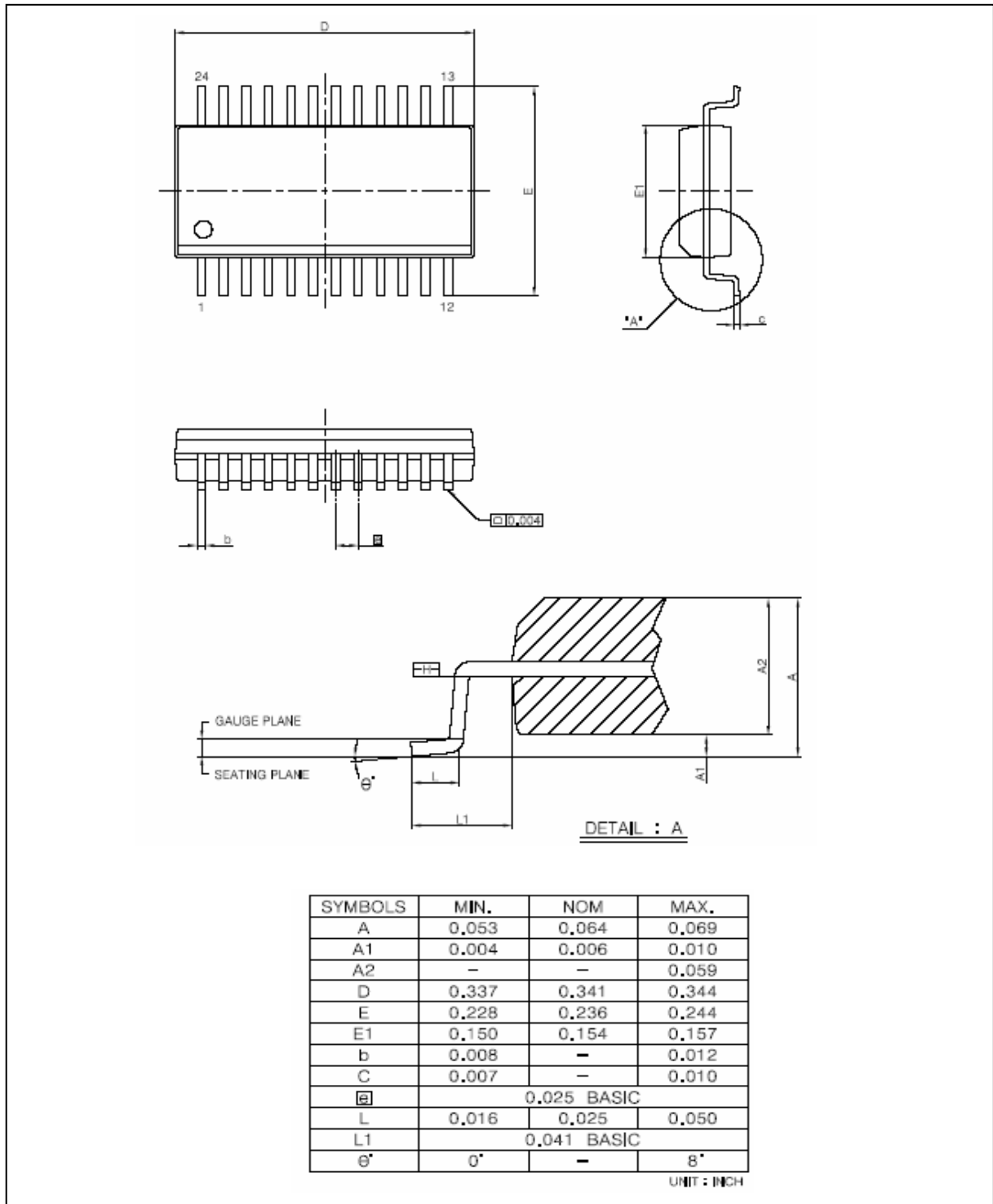
TIMING DIAGRAM FOR APPLICATION CIRCUIT 1 (Default One Shot Mode)



TIMING DIAGRAM FOR APPLICATION CIRCUIT 2 (Default One Shot Mode)



PACKAGE INFORMATION
LD1071-SP (SOP 24)


LD1071-SS (SSOP 24 – 150)


The products listed herein are designed for ordinary electronic applications, such as electrical applications, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instrument, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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